

RYAN R. WIXOM

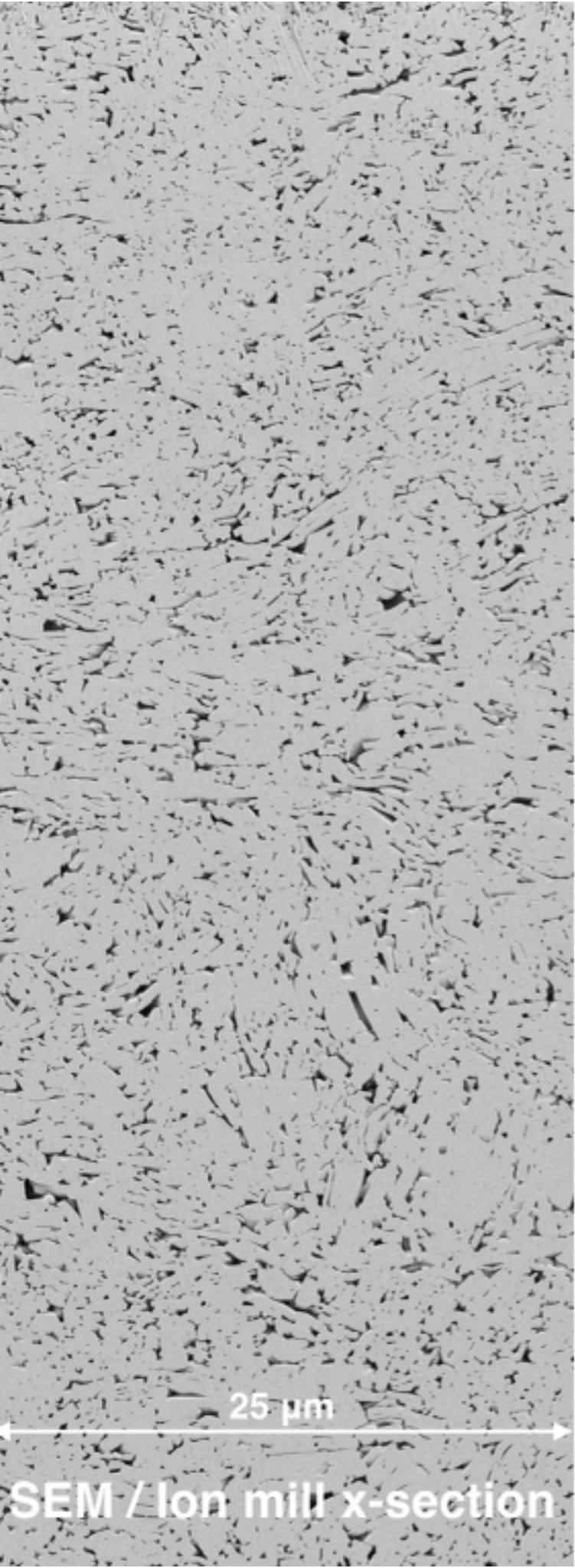
MICROSTRUCTURAL CHARACTERIZATION OF ENERGETIC MATERIALS

PEOPLE

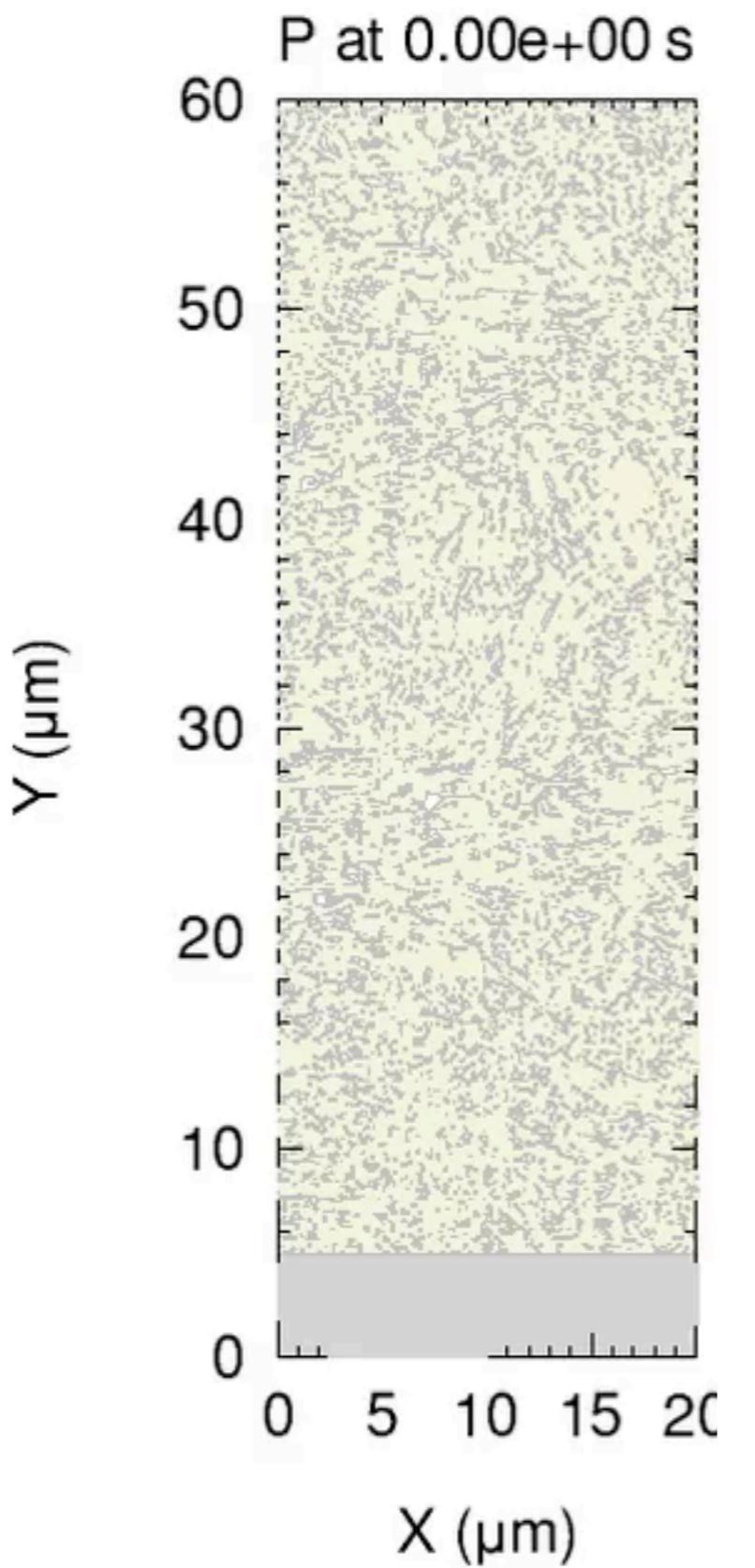
- Dave Jones, Eric Welle, [Mel Baer](#), Alex Tappan
- Joe Michael, Micheal Rye
- **Barry Ritchey**, [Cole Yarrington](#), [Rob Knepper](#), David Damm
- Chris Molek (HMX and analysis)
- Todd Reedy (low density CL-20)
- Marcia Cooper, Graham Kosiba (RPI APCP characterization)

Questions / Topics of discussion:

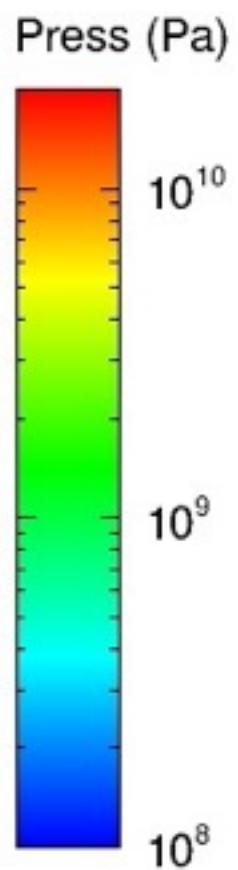
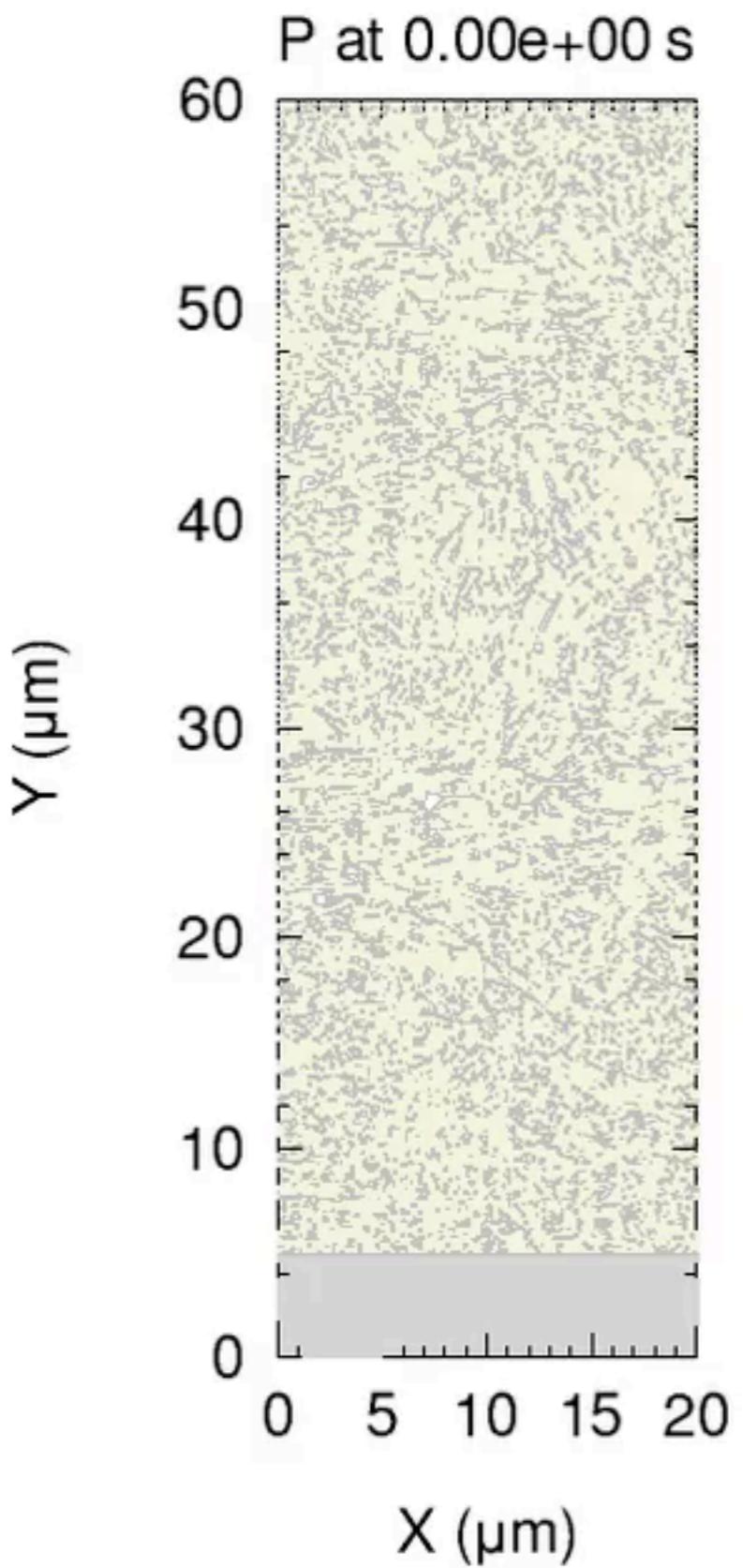
- What will the data be used for?
 - empirical correlations, simulation, parameterization, validation
- How should it be analyzed?
- When do you need 3D data? Will 2D do?
- Explicit microstructural or representative?
- What resolution and FOV is needed? What's possible?
- Which is better, Optical, SEM, FIB/SEM, xCT, AFM, XRD...



Flyer impact 1500 m/s

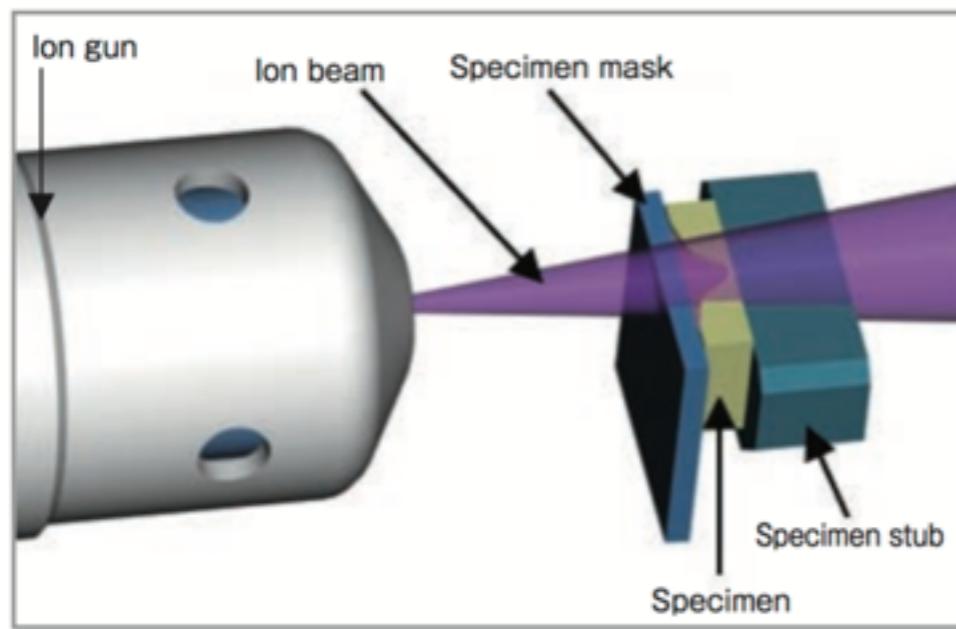


2500 m/s



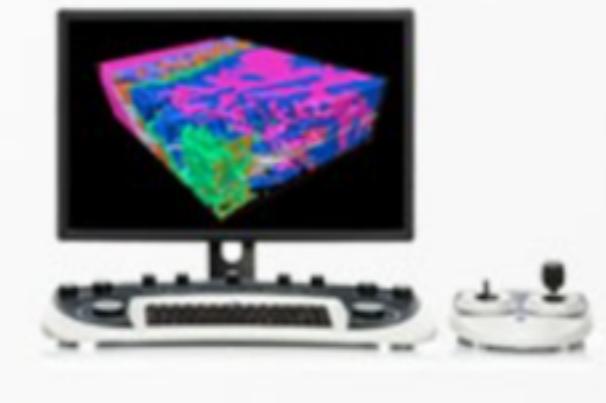
aluminum flyer impacting hexanitrostilbene

\$
Ar ion-beam
cross-sections
Hitatchi IM4000



Schematic diagram for processing of Cross-section milling

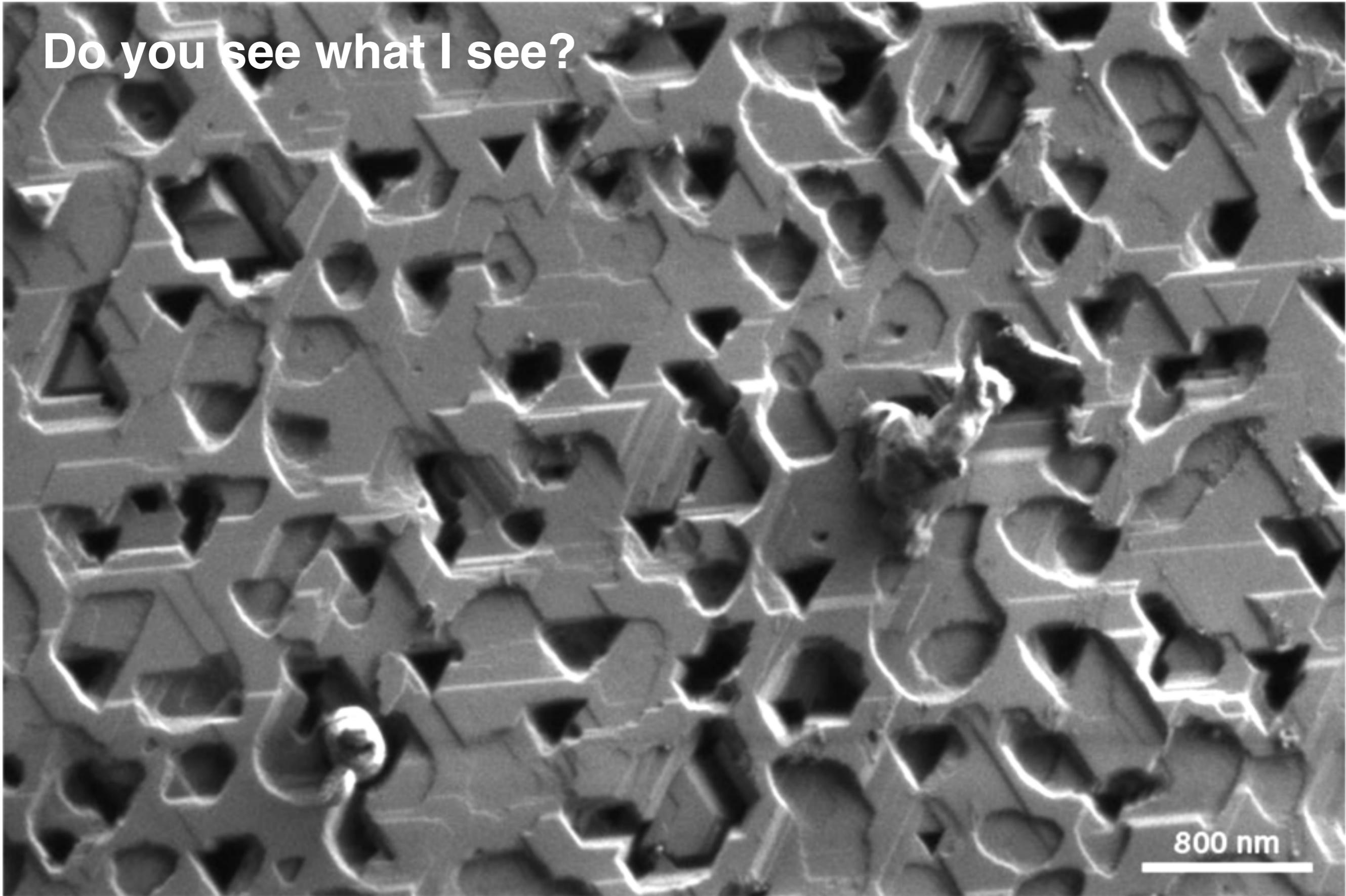
FIB/SEM Zeiss Cross-beam
\$\$\$



Zeiss / Xradia
Versa 520

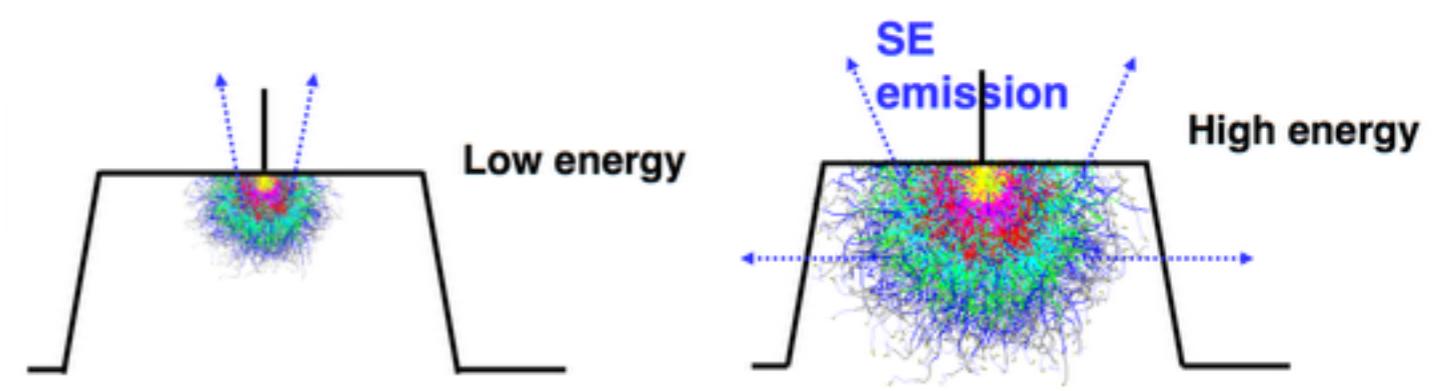
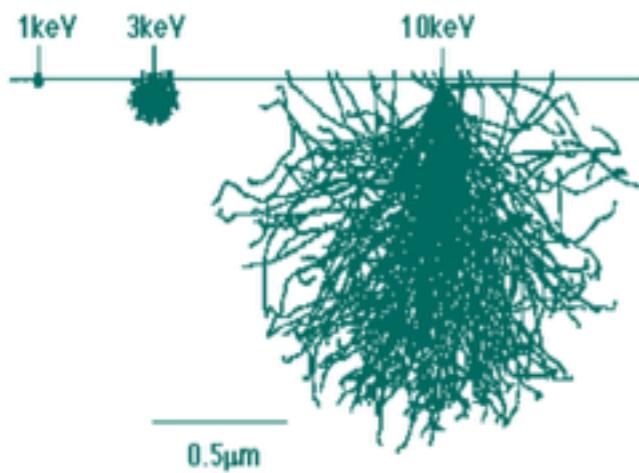
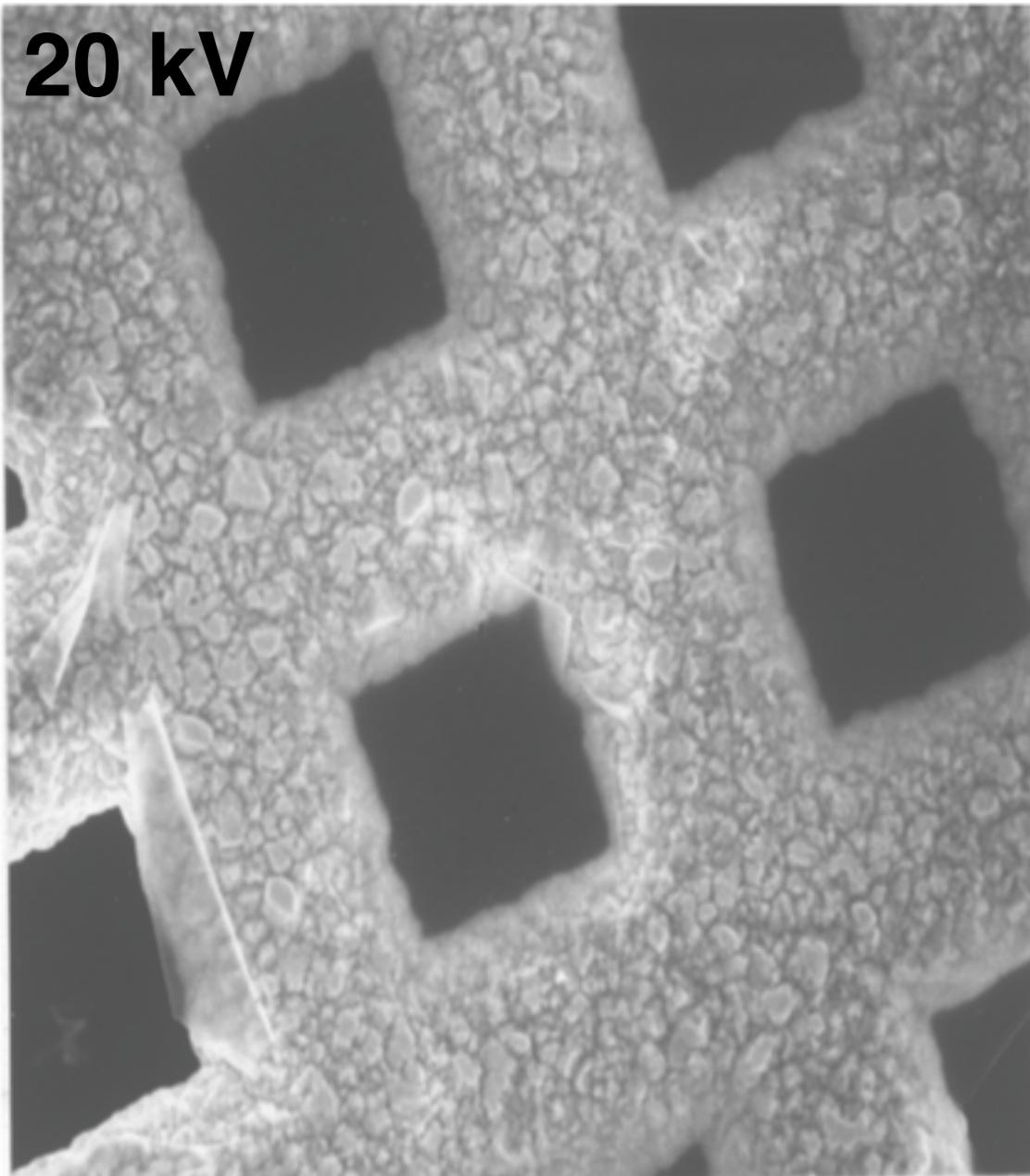


Do you see what I see?

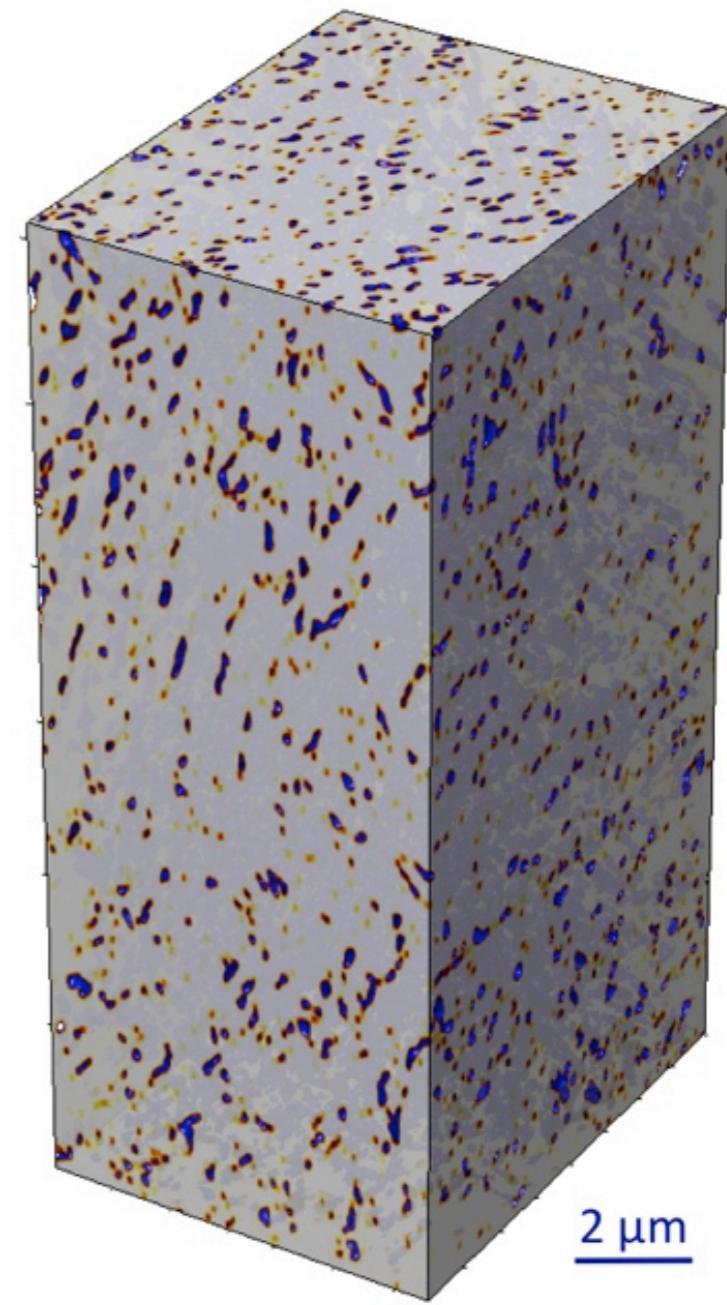
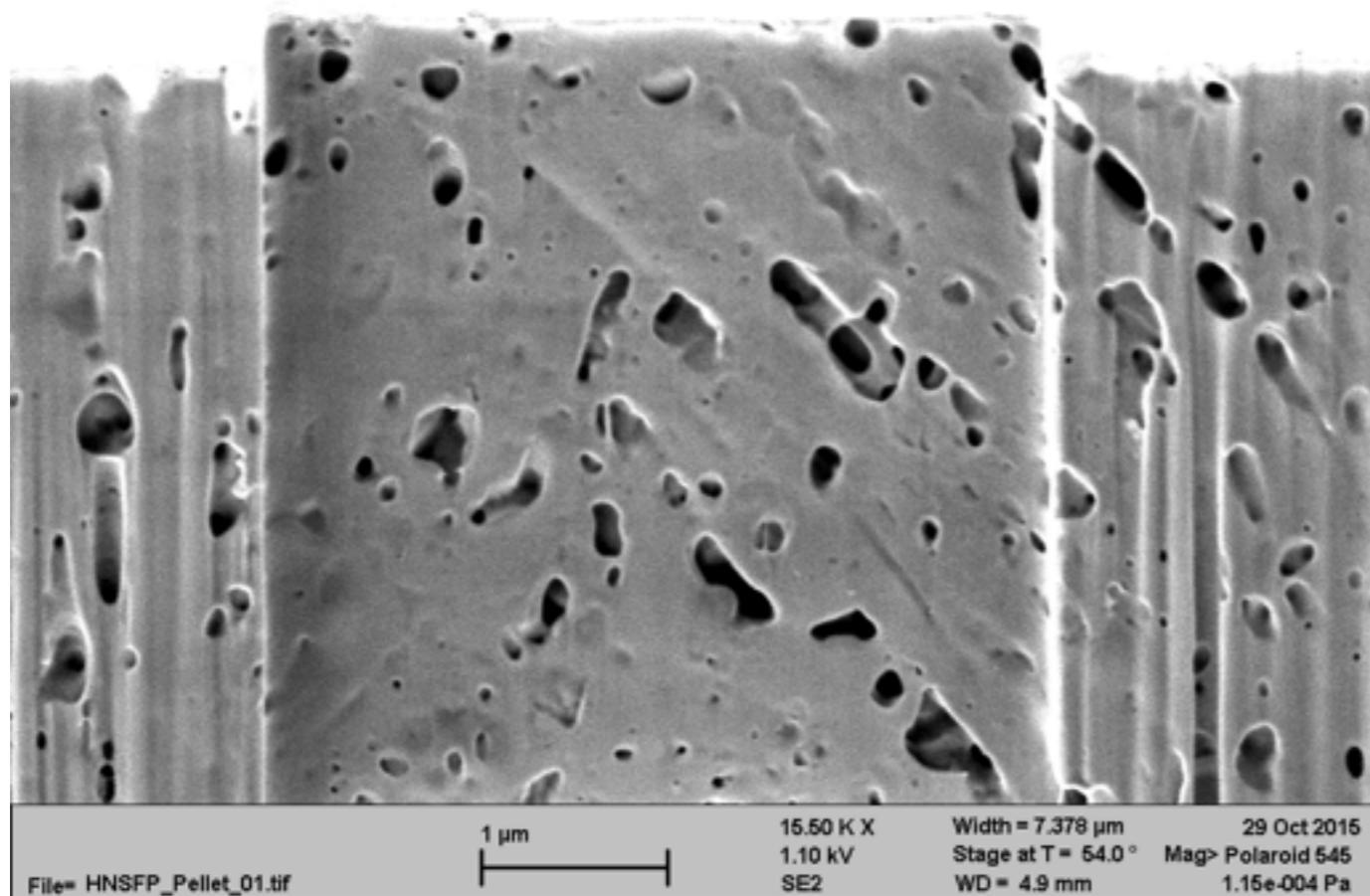
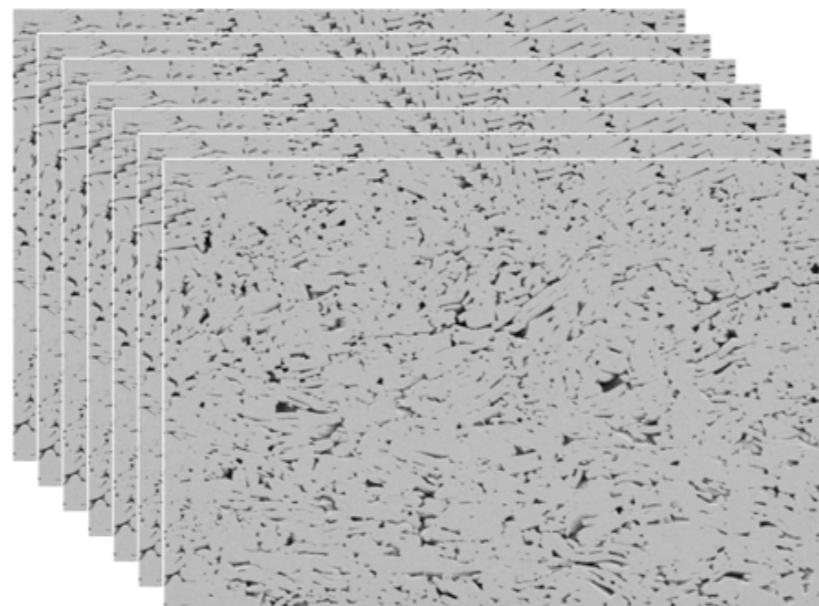
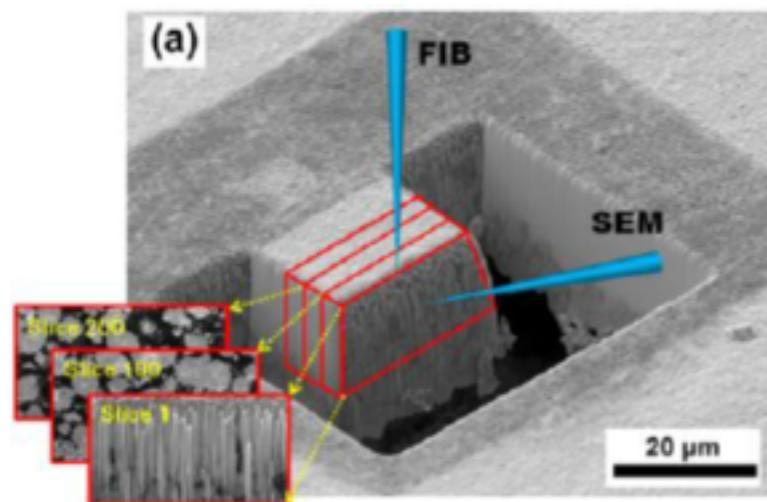


Etched silicon nanostructures at 50 V, no sample biasing. Imaged with GeminiSEM 500.
Sample: courtesy of A. Charai, Aix Marseille University, France.

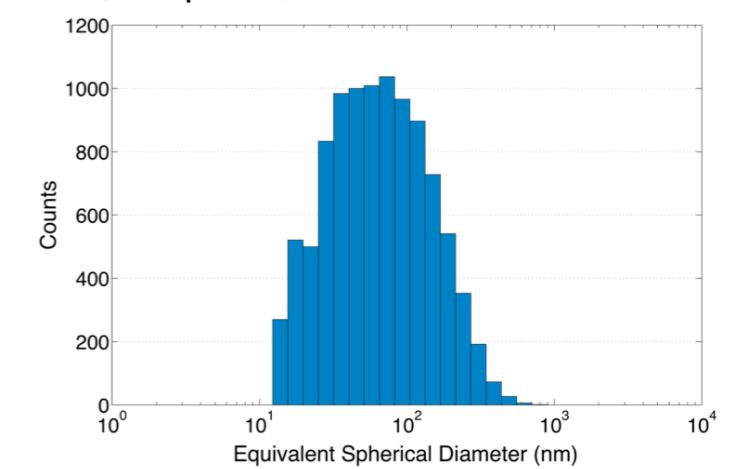
Be nice to your sample. Less voltage, please.



FIB/SEM Nanotomography



80,000 pores, mean diameter 86.3 nm



Ion beam cross-sectioning

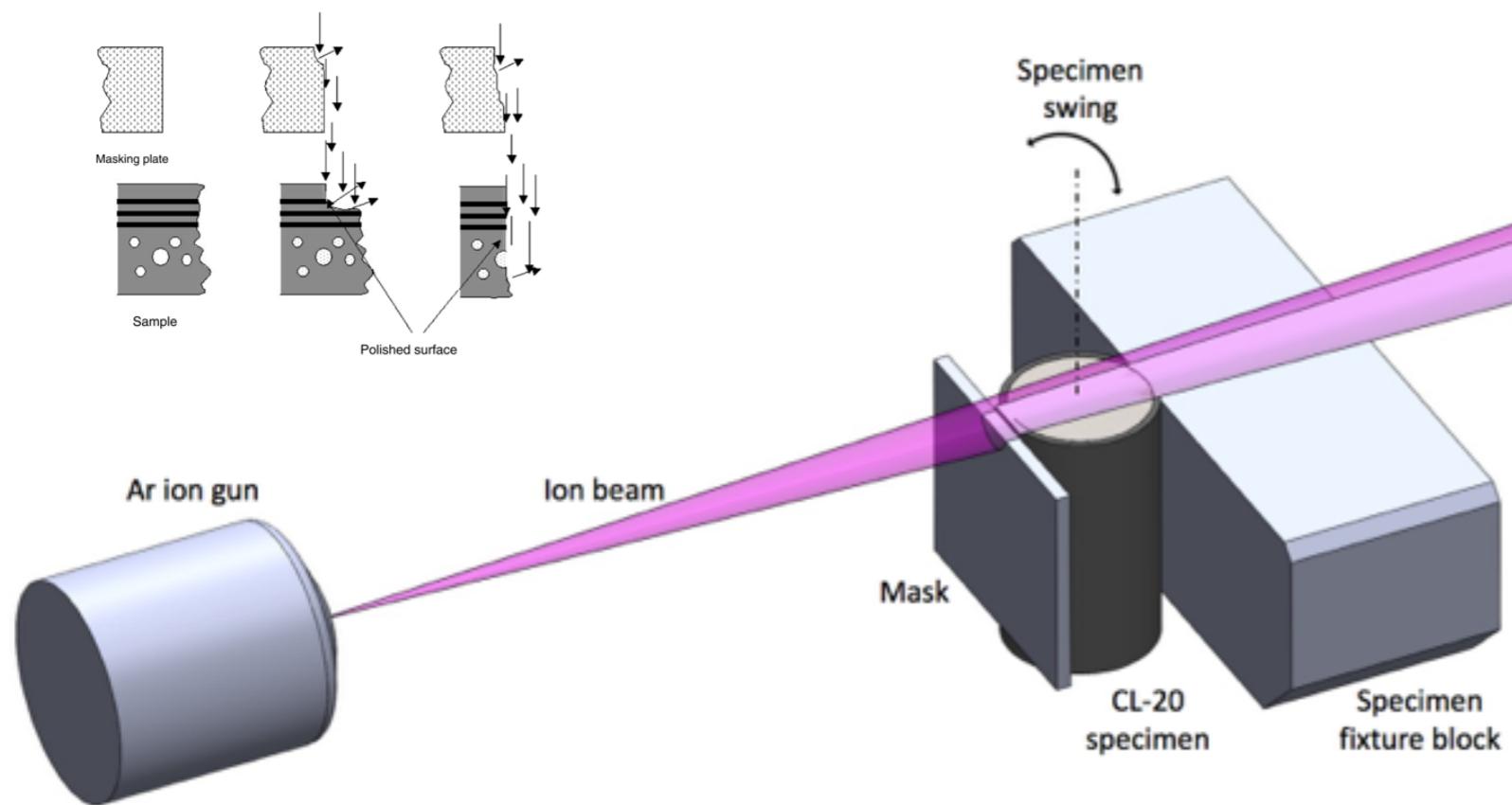
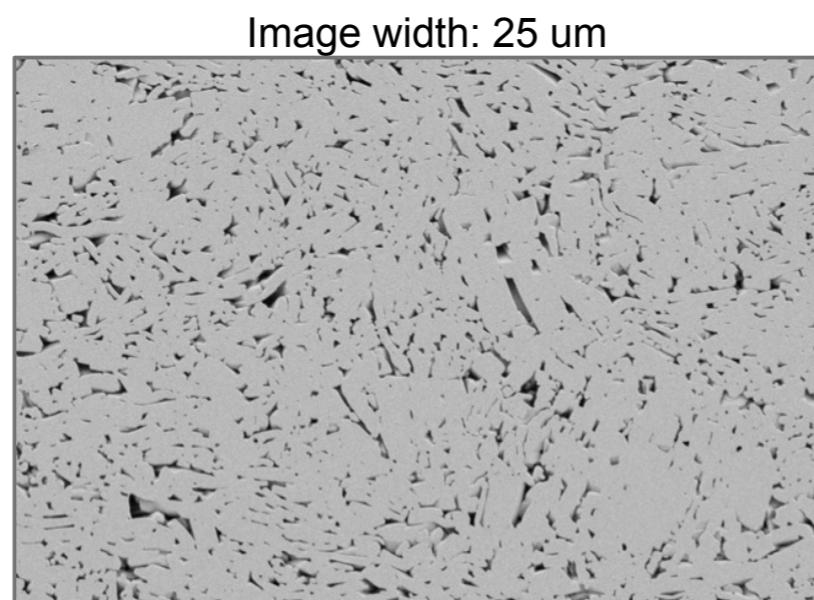
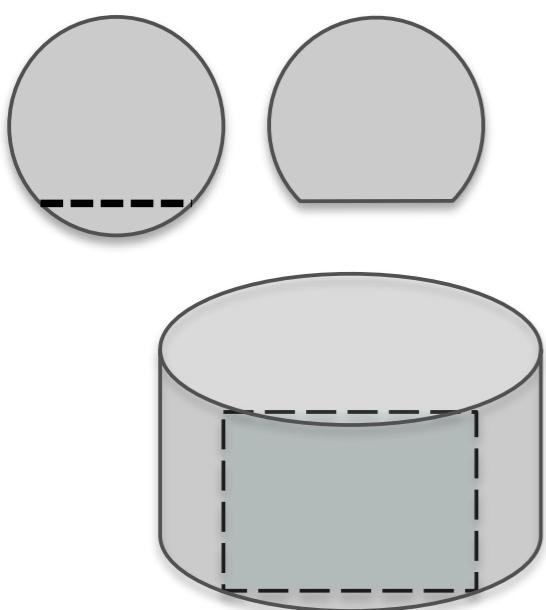


Figure 2-4. Schematic of cross-sectional ion milling.



HNS-FP, 90% TMD

CL-20: 50% 70% 90% TMD

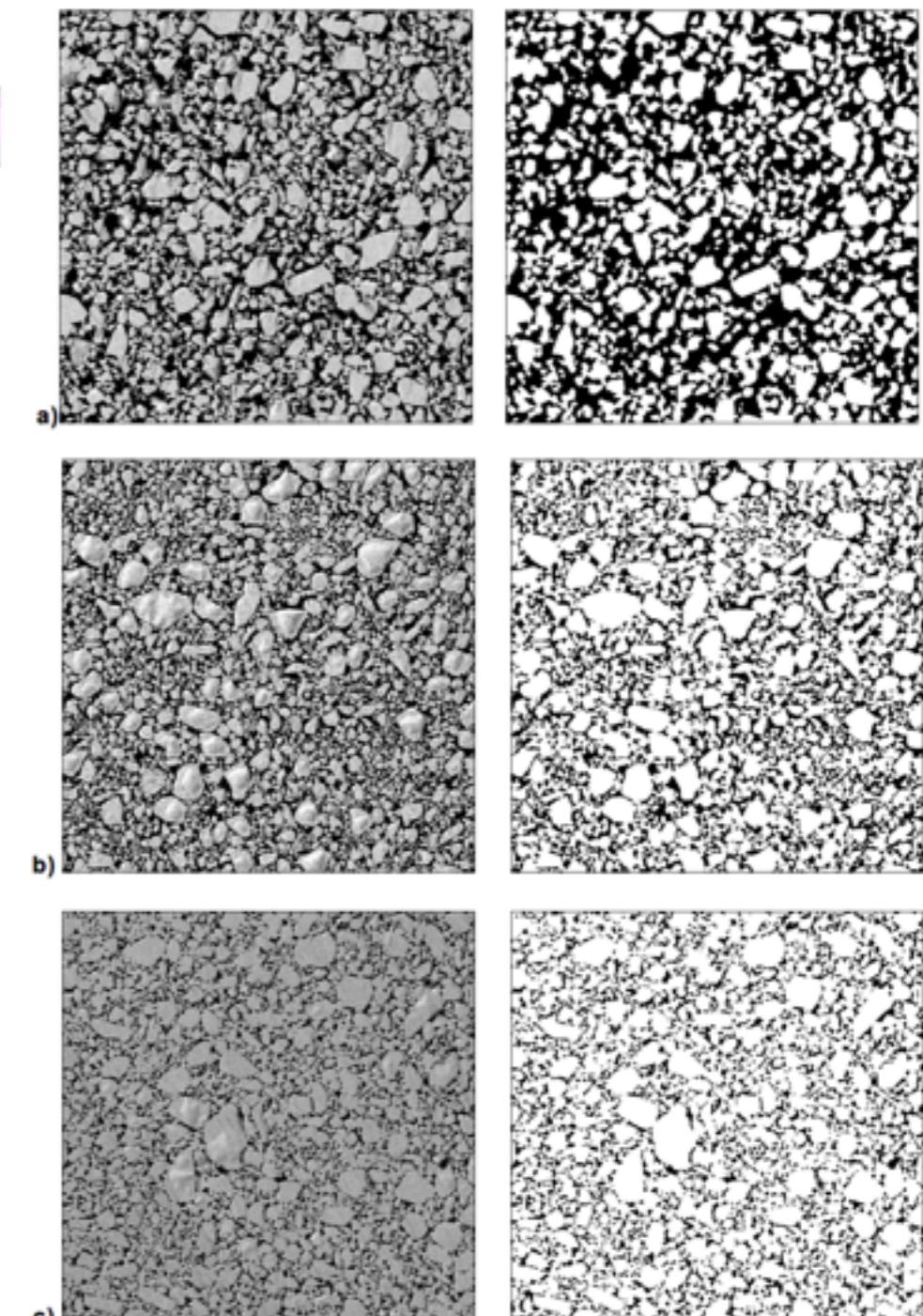
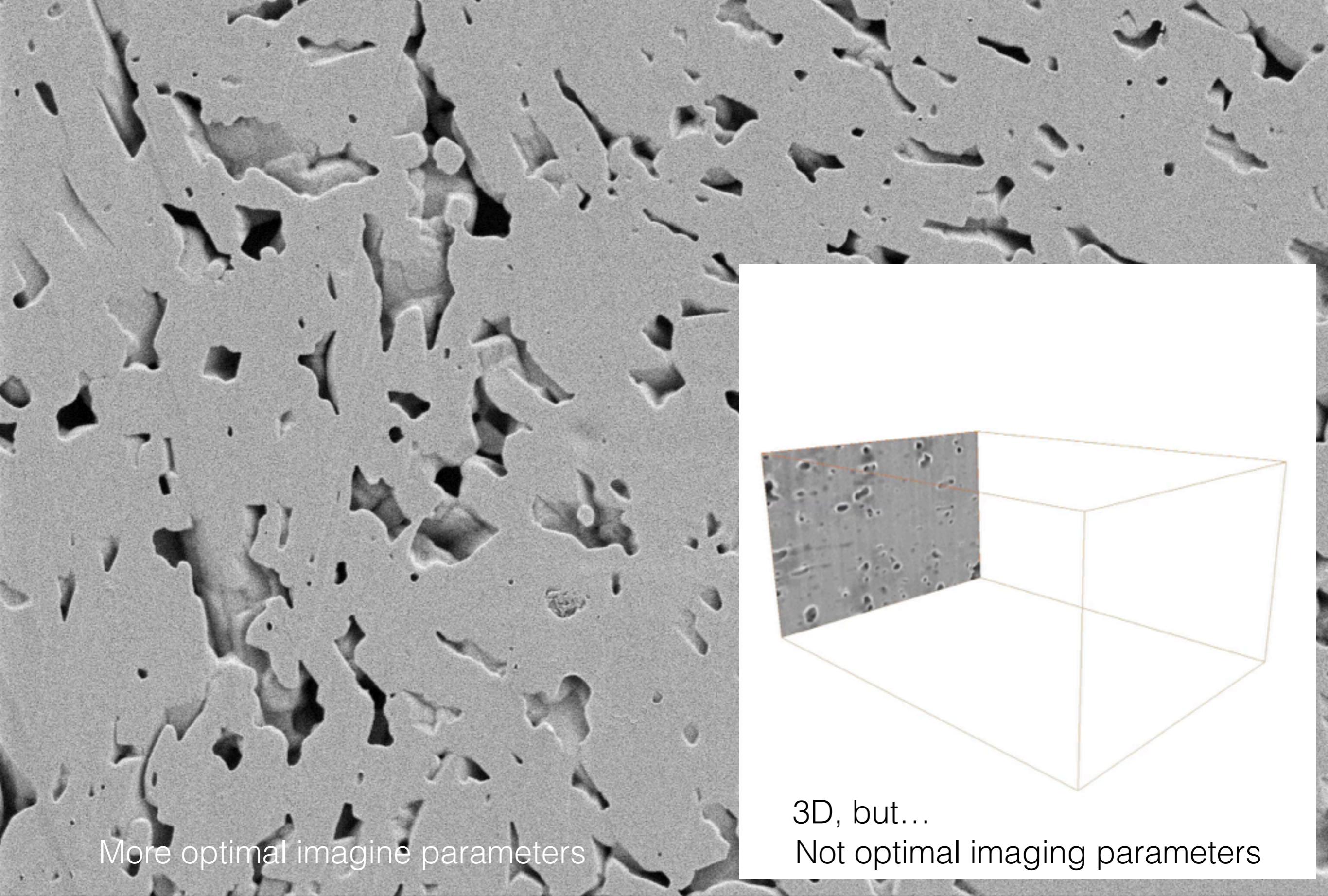


Figure 2-8. Ion-milled cross-section electron images of powder A pressed to nominally a) 50% TMD, b) 70% TMD, and c) 90% TMD. The image in right column is a segmented binary representation of the micrograph shown in the left column. Each image is 50 μm by 50 μm .

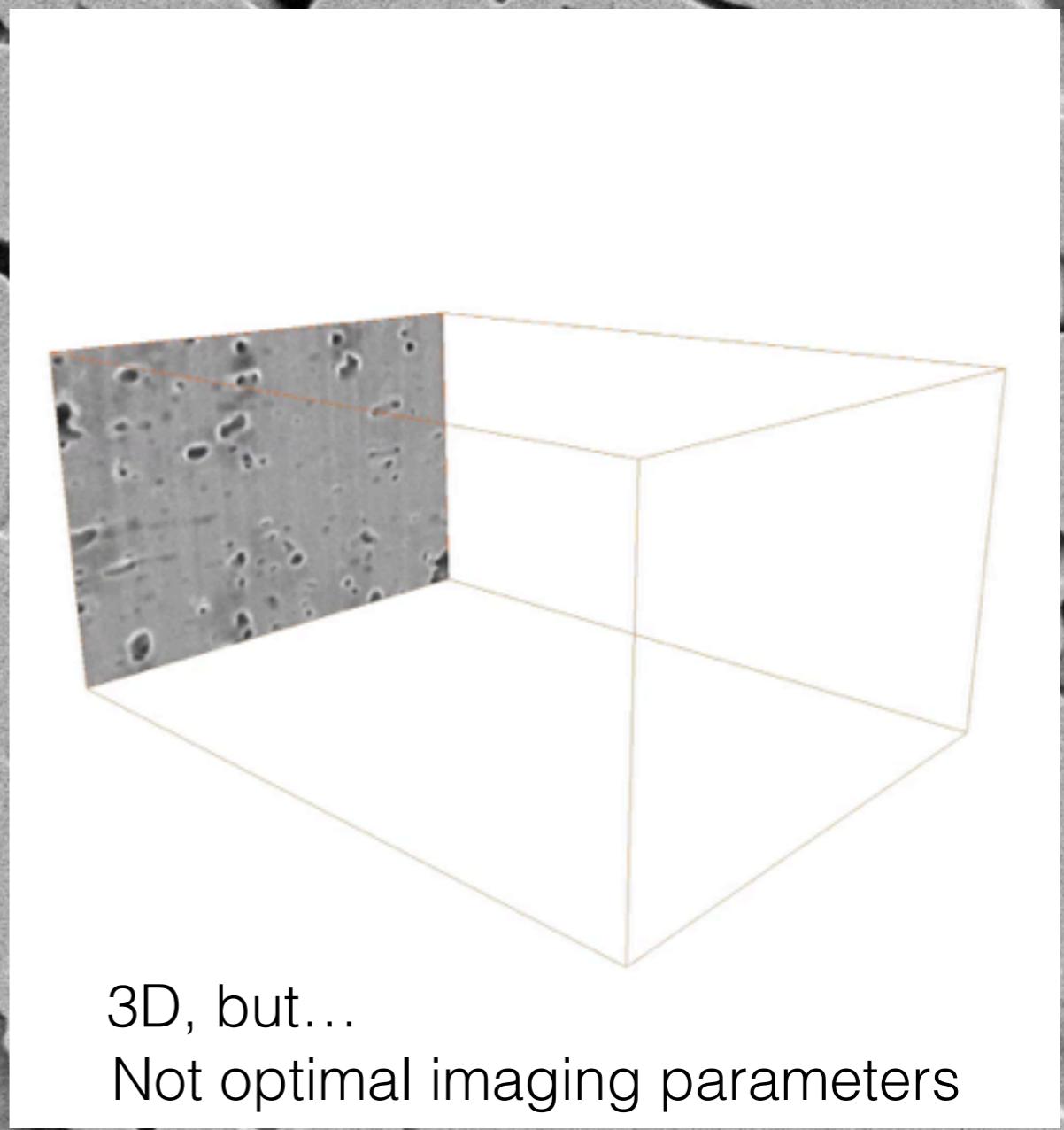
x-ray computed tomography

CL-20 50% TMD
threshold no-go
1 mm crater





More optimal imagine parameters



3D, but...
Not optimal imaging parameters

HNS-10

1 μ m

EHT = 1.50 kV

WD = 4.3 mm

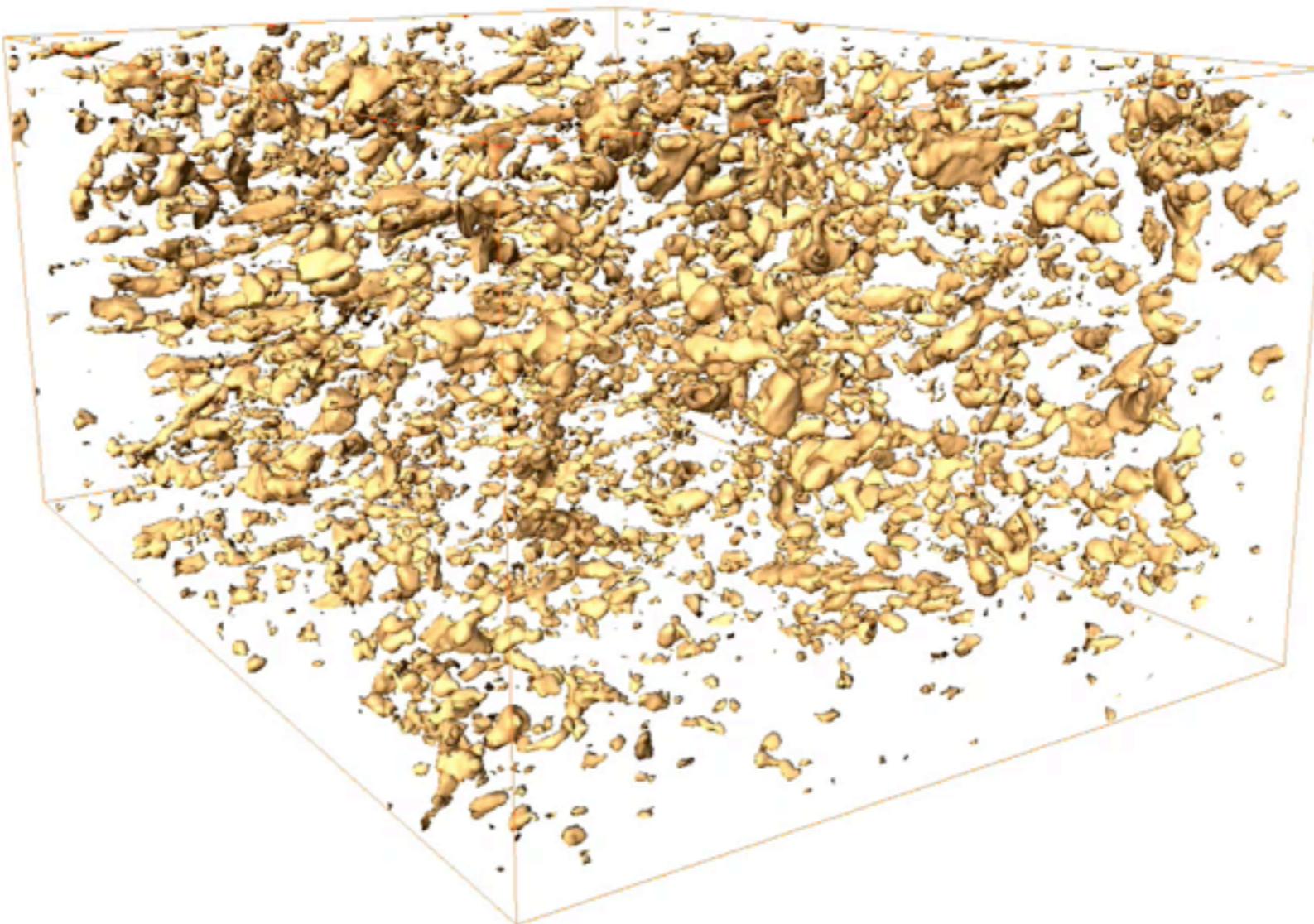
Date :21 Apr 2009

Mag = 25.00 K X

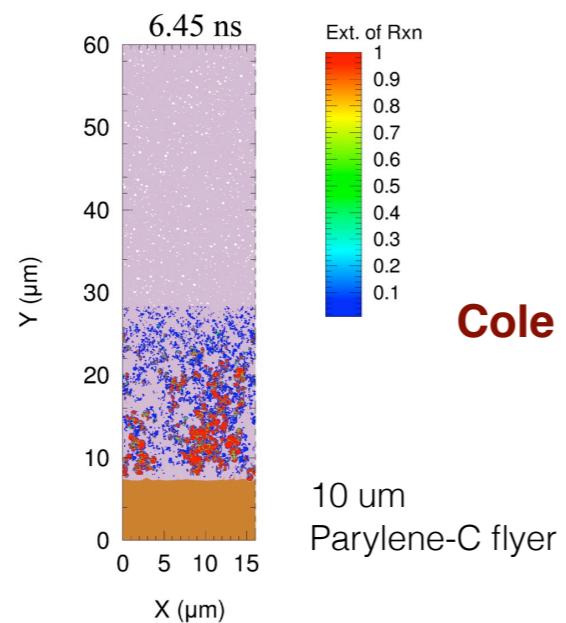
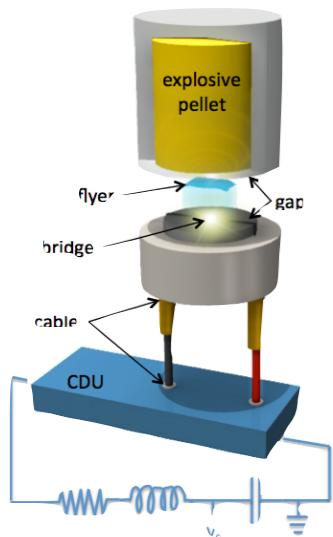
Signal A = SE2

Time :11:27:32

Obligatory spinning image

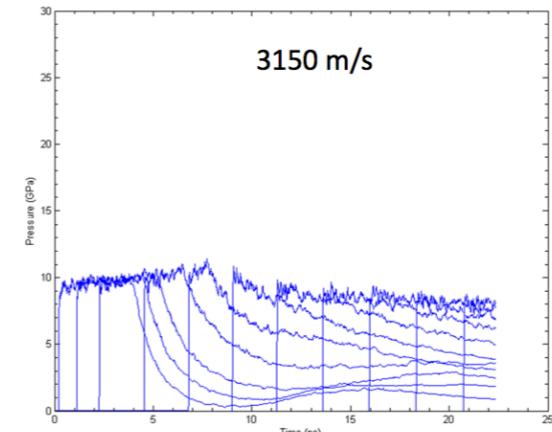


Mesoscale simulations with 'equivalent' microstructure

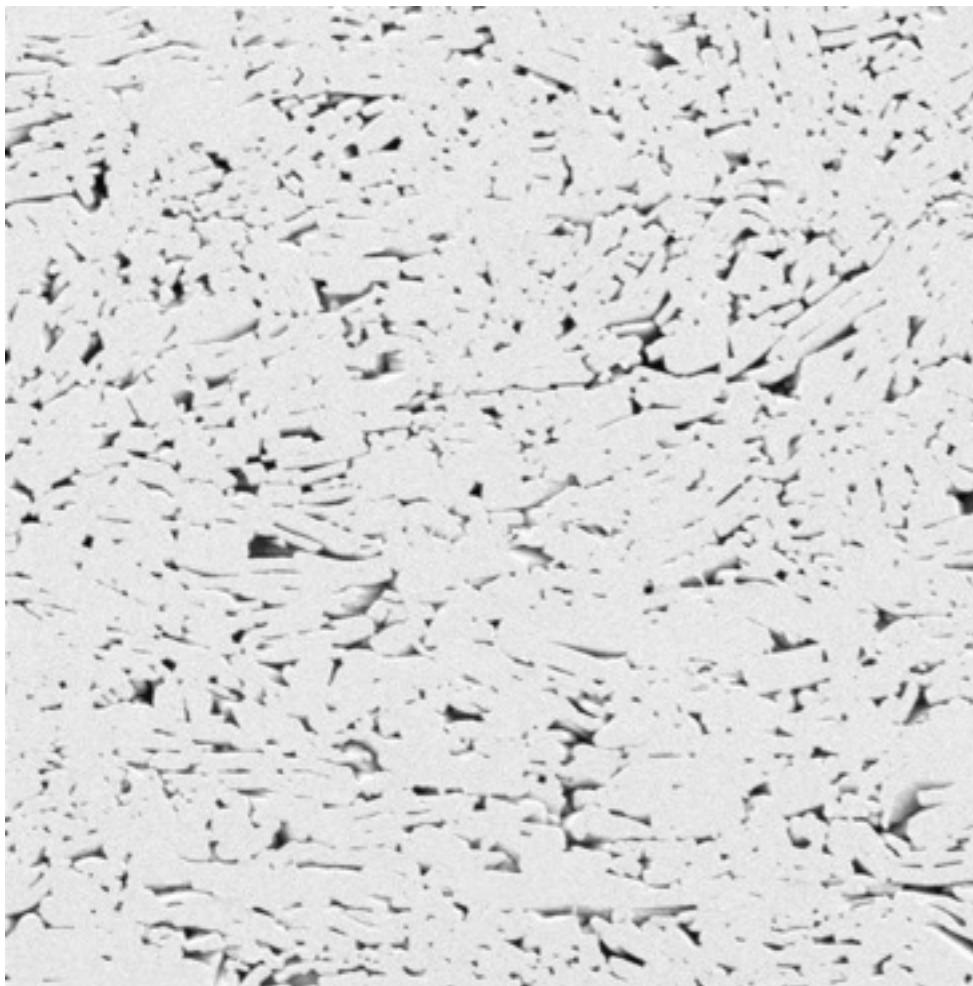


Cole Yarrington
SNL

Predicts a shift in run distance with increasing pore size



Ion mill cross section



HNS-FP #6 Ion Polish
= HNS-FP 6 I-Pol 10000x-2.tif

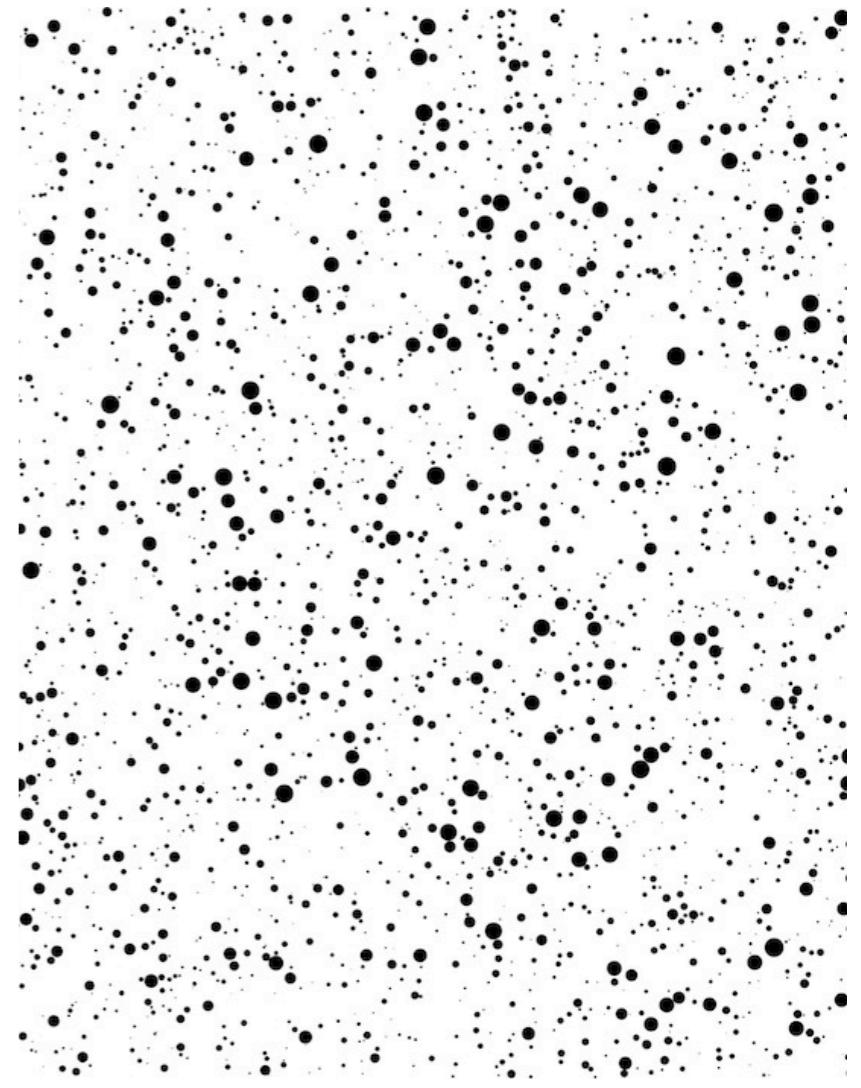
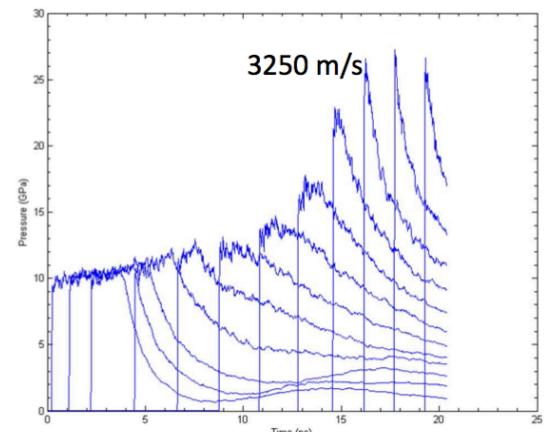
1 μm

Mag = 10.00 K X
Width = 25.36 μm
EHT = 1.00 kV

segmented



equivalent



Collaboration with AFRL (Eric Welle and Chris Molek)

Class III

Class V

PBX N5

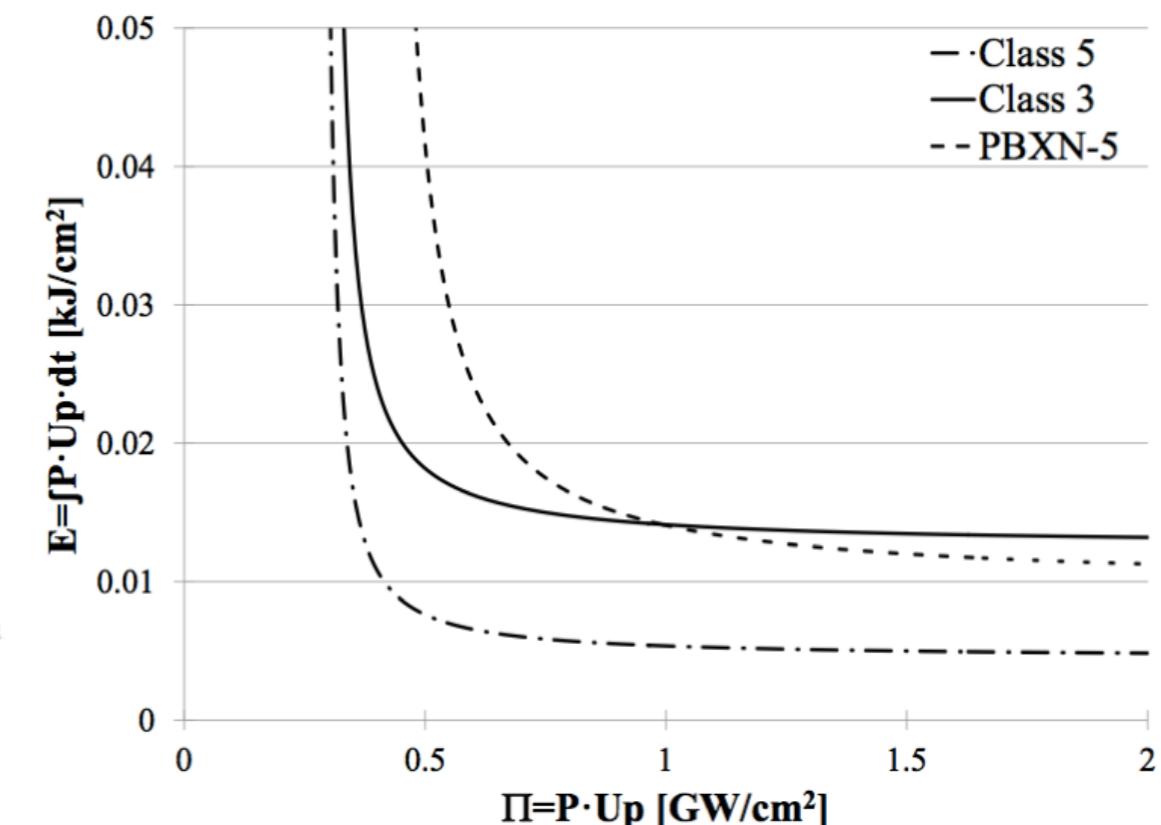
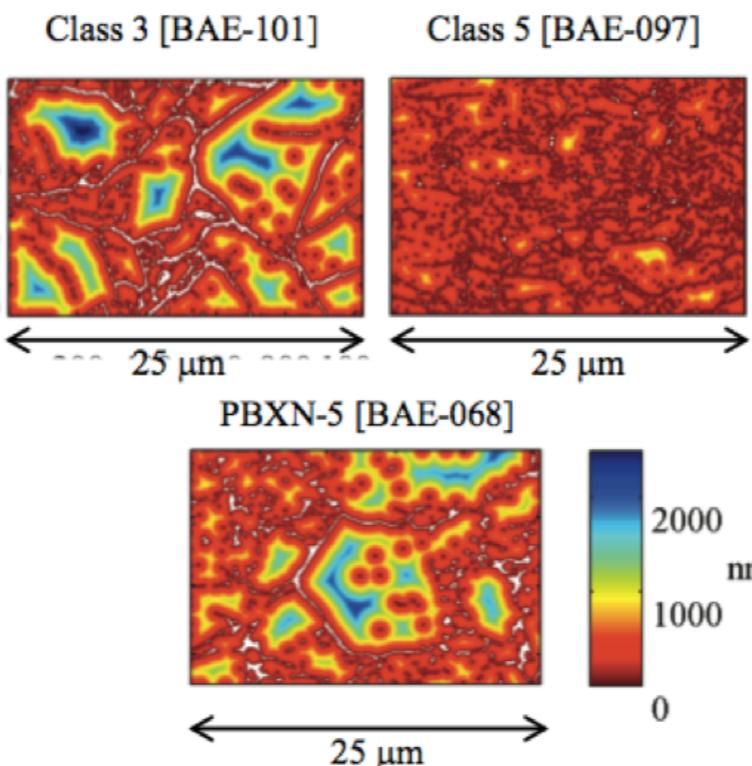
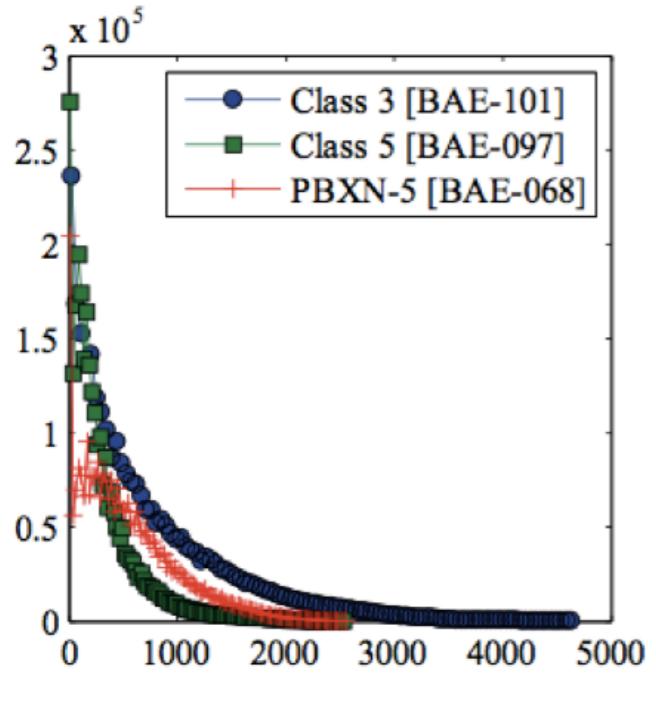
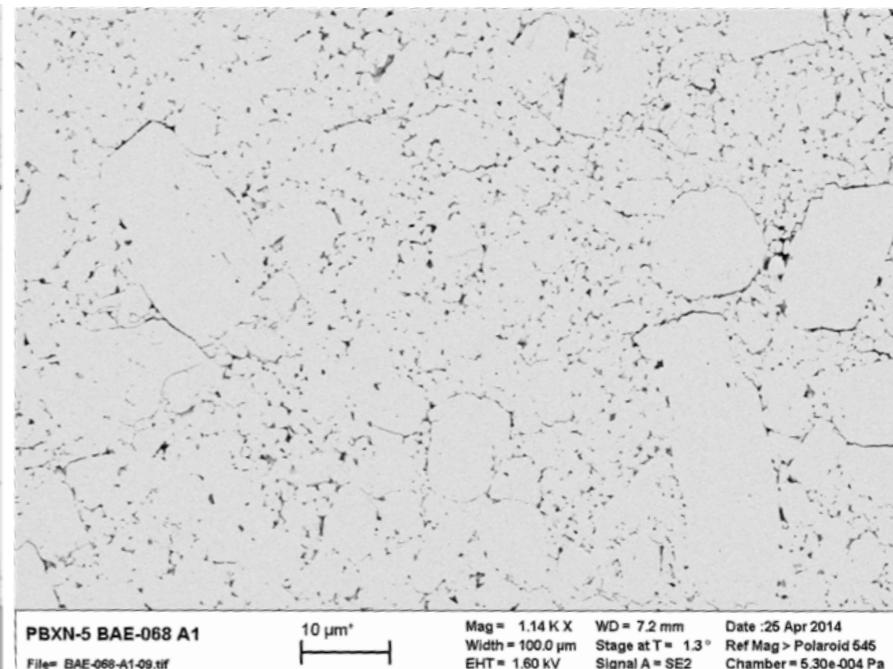
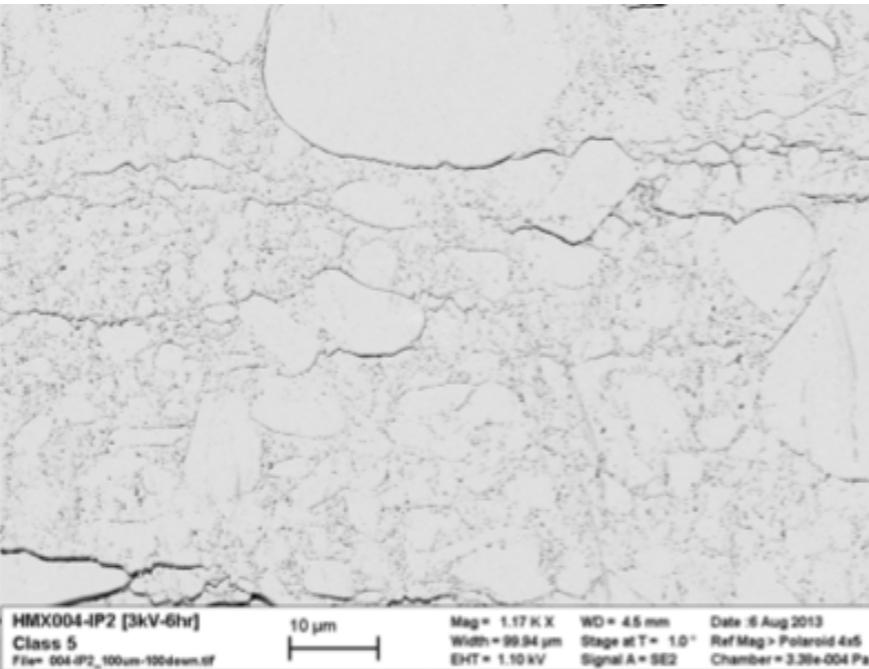
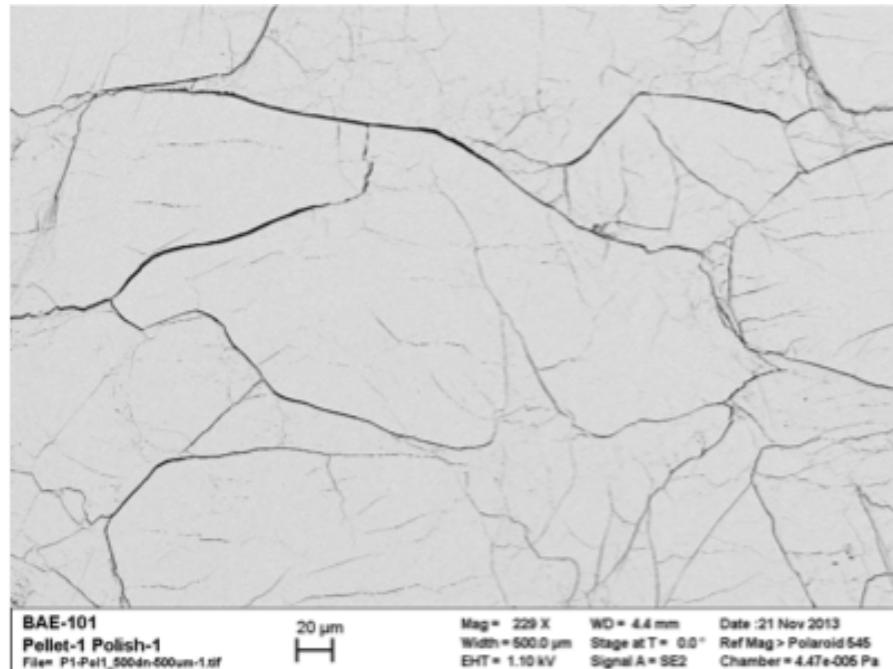


Fig. 7. Trend lines fit to initiation threshold data.

FIB/SEM, HINTS OF AMAZING THINGS TO COME

Chris Molek and Jim Vitarelli
AFRL



100 μm
H

30.00 μm

Imaging Mode: SEM

30kV:65nA

Width = 2.918 mm

EHT = 3.00 kV

Signal A = SE2

WD = 5.9 mm

Image Pixel Size = 2.849 μm

Mag = 39 X

InlensDuo Grid = 0 V

54.0 °

Class 5
94% TMD
Pellet #1

Class 5
94% TMD
Pellet #1

Class 5
94% TMD
Pellet #1

Class 5
94% TMD

Class 5
94% TMD

Class 5
94% TMD

Image stitching

vs

Large area acquisition

Dynamic

Static

H 1 = 3.121 mm

V 1 = 3.164 mm

200 μ m

30.00 μ m

EHT = 5.00 kV

Mag = 23 X

Imaging Mode: SEM

Signal A = SE2

InlensDuo Grid = 408 V

30kV:50pA ref

WD = 35.4 mm

0.0 °

Width = 4.970 mm

Image Pixel Size = 4.853 μ m

Dynamic



Static

H 1 = 3.121 mm

V 1 = 3.164 mm

200 μ m
H

30.00 μ m

EHT = 5.00 kV

Mag = 23 X

Imaging Mode: SEM

Signal A = SE2

InlensDuo Grid = 408 V

30kV:50pA ref

WD = 35.4 mm

0.0 °

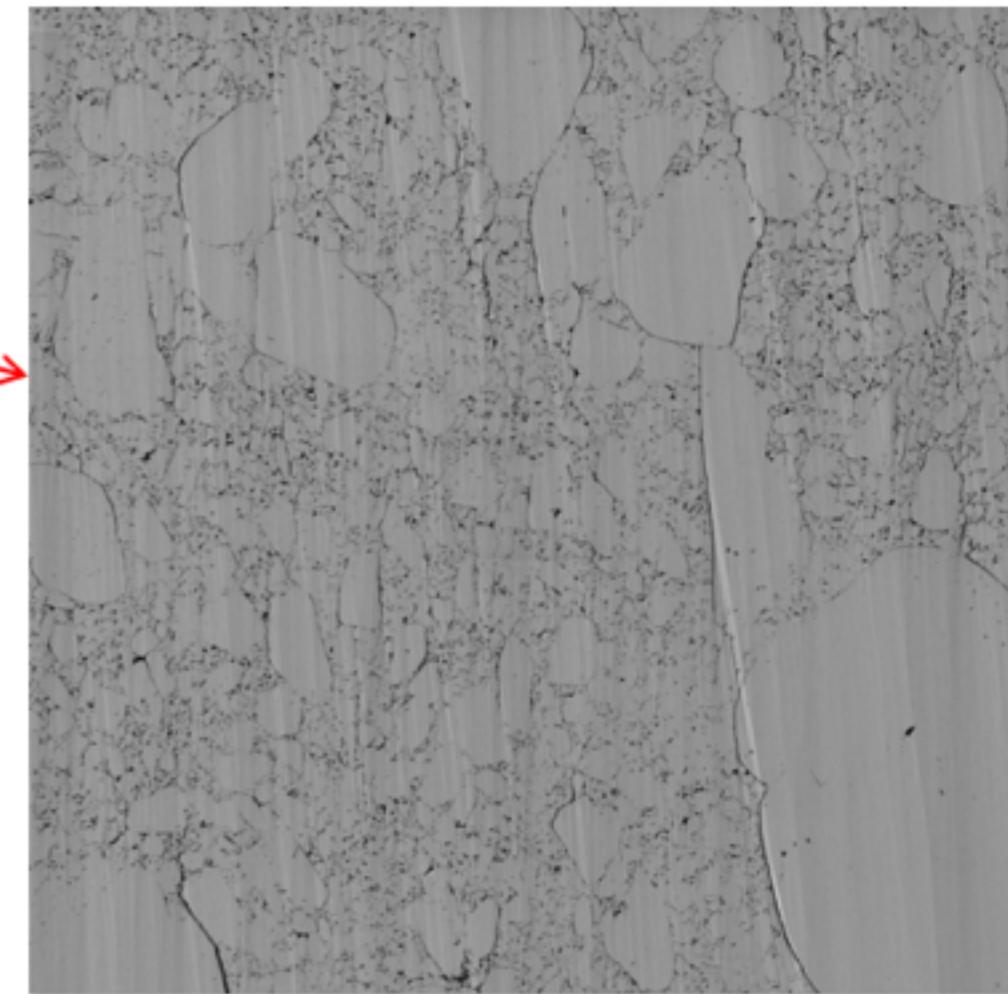
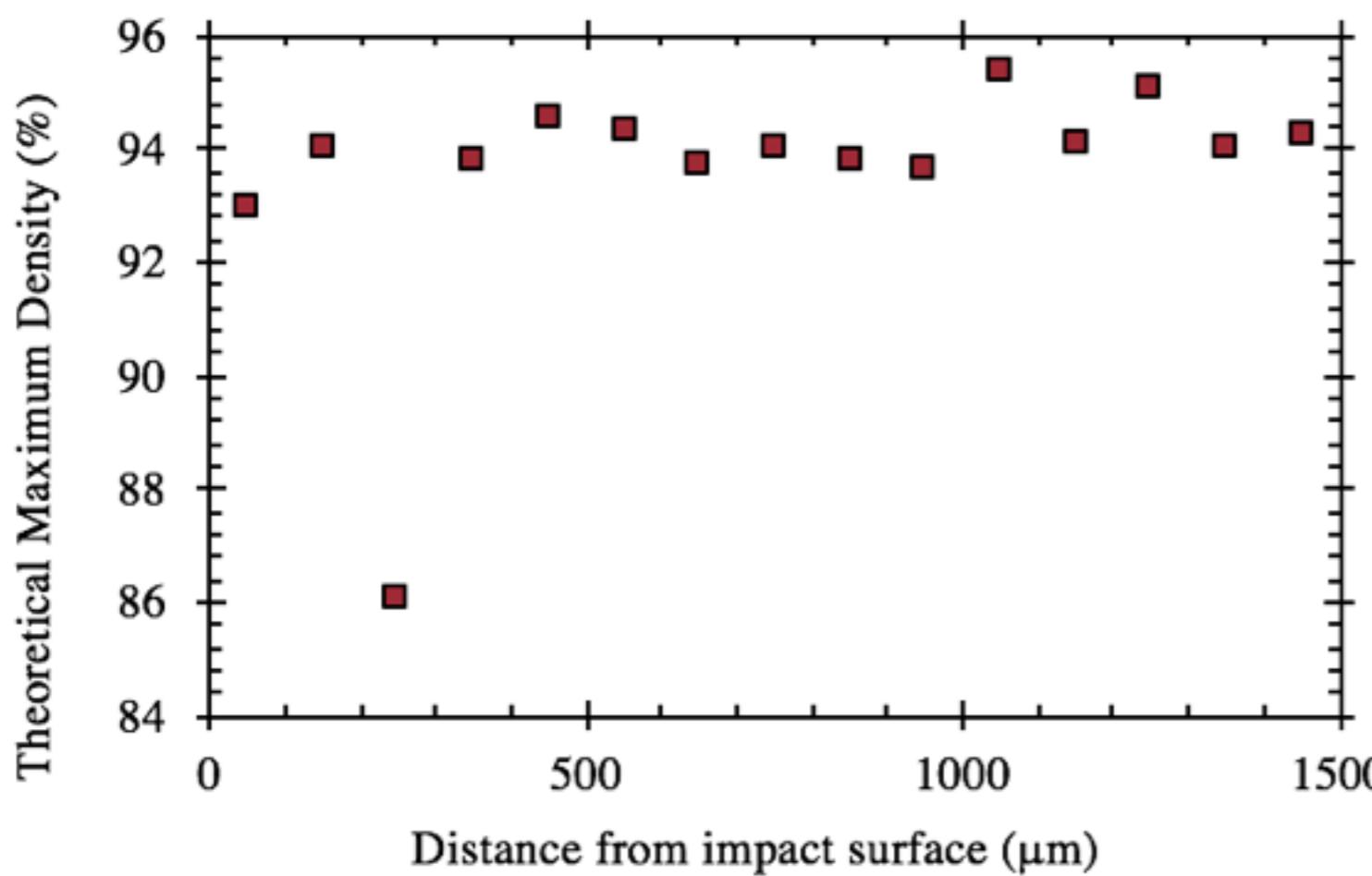
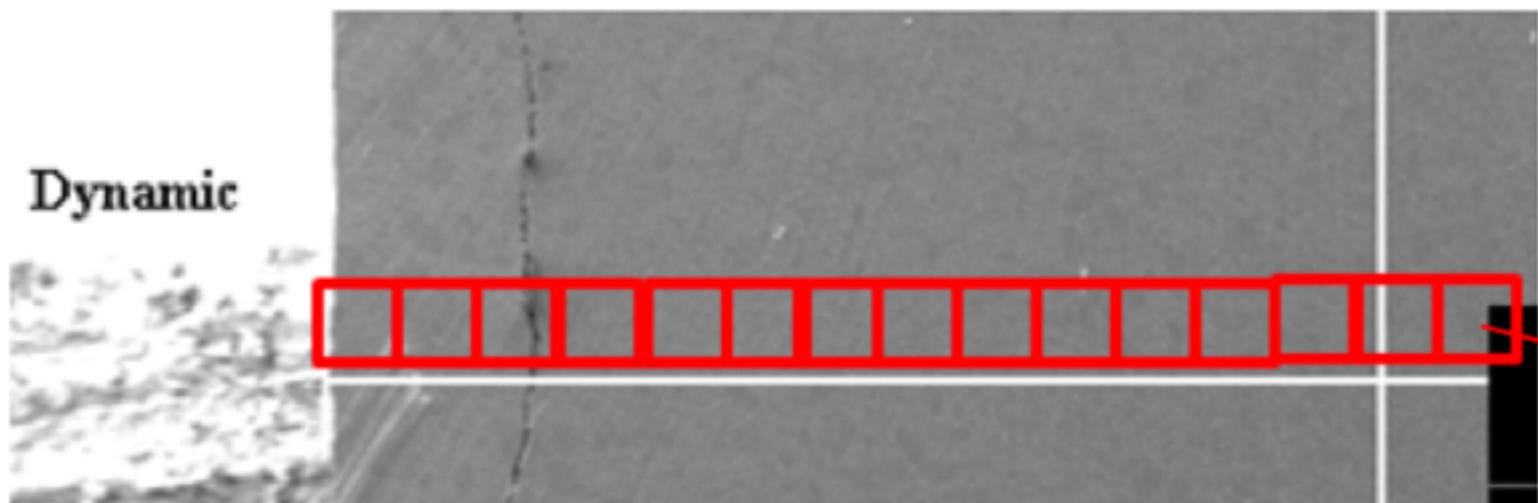
Width = 4.970 mm

Image Pixel Size = 4.853 μ m



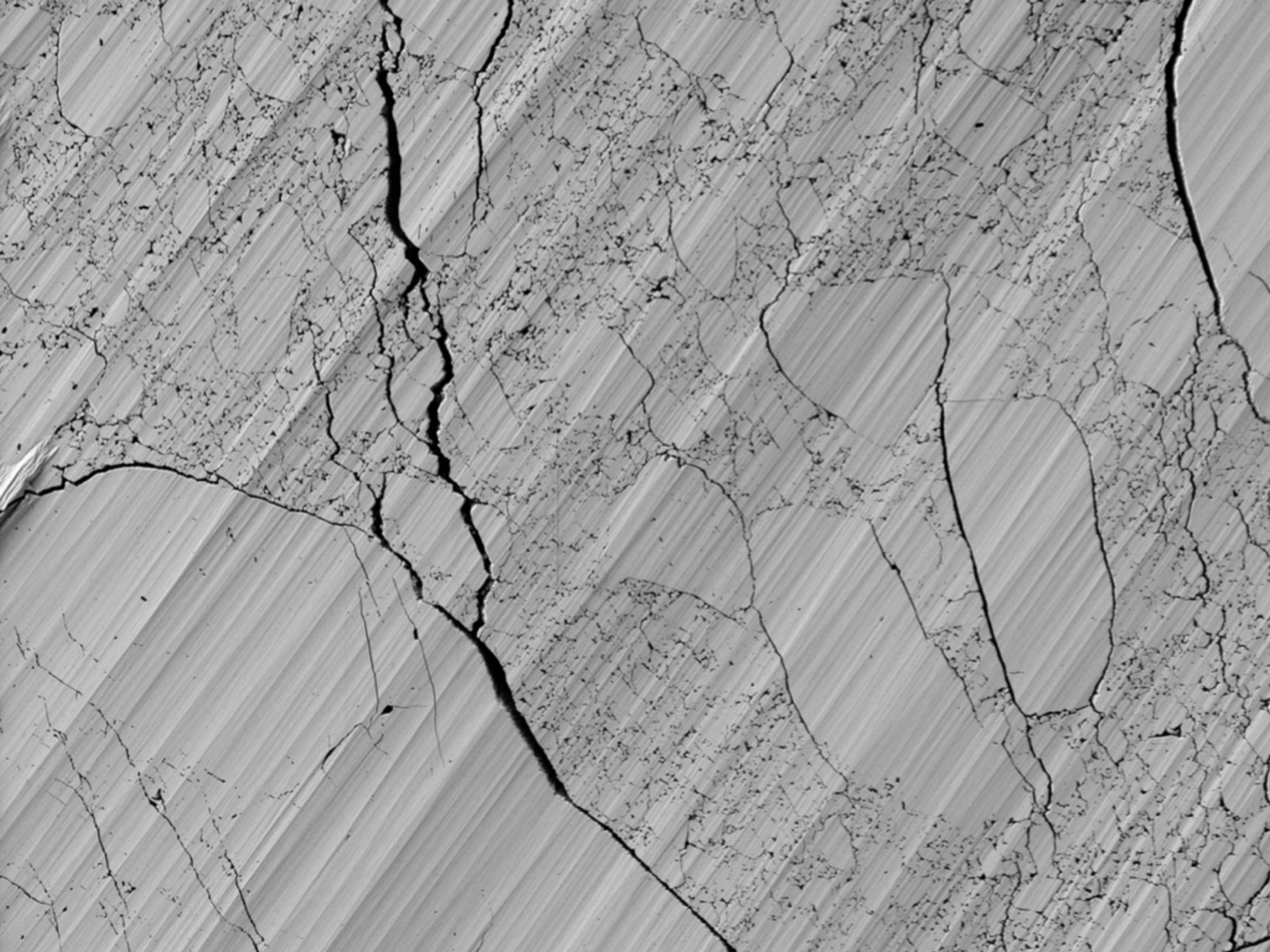
Density Variation as a Function of Depth

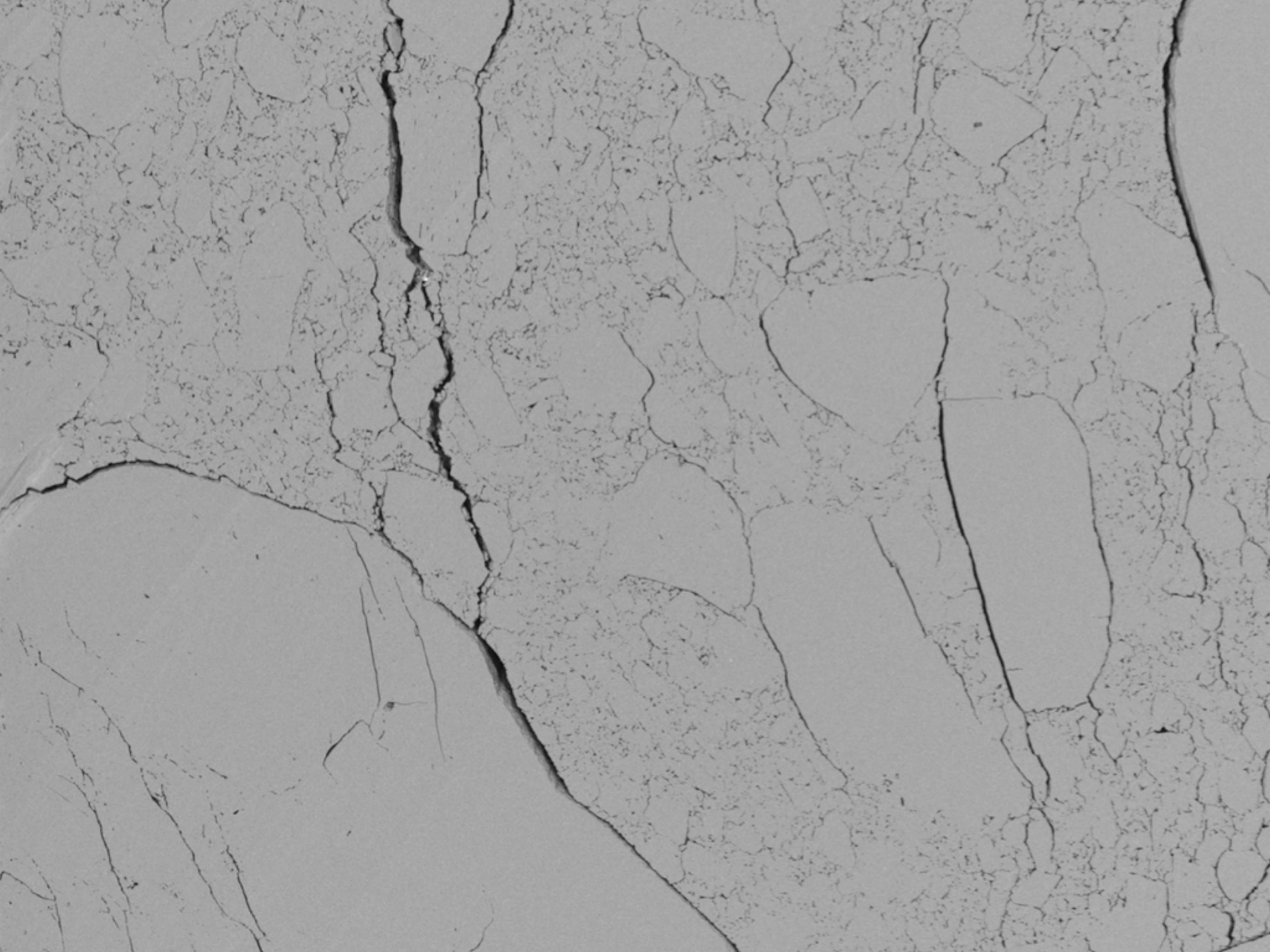
Dynamic



Class 5 at nominal 94% TMD

- Each image 100 μm square and 9.8 nm pixel size
- SIA is 0.0024 (0.0002) nm^2/nm^3



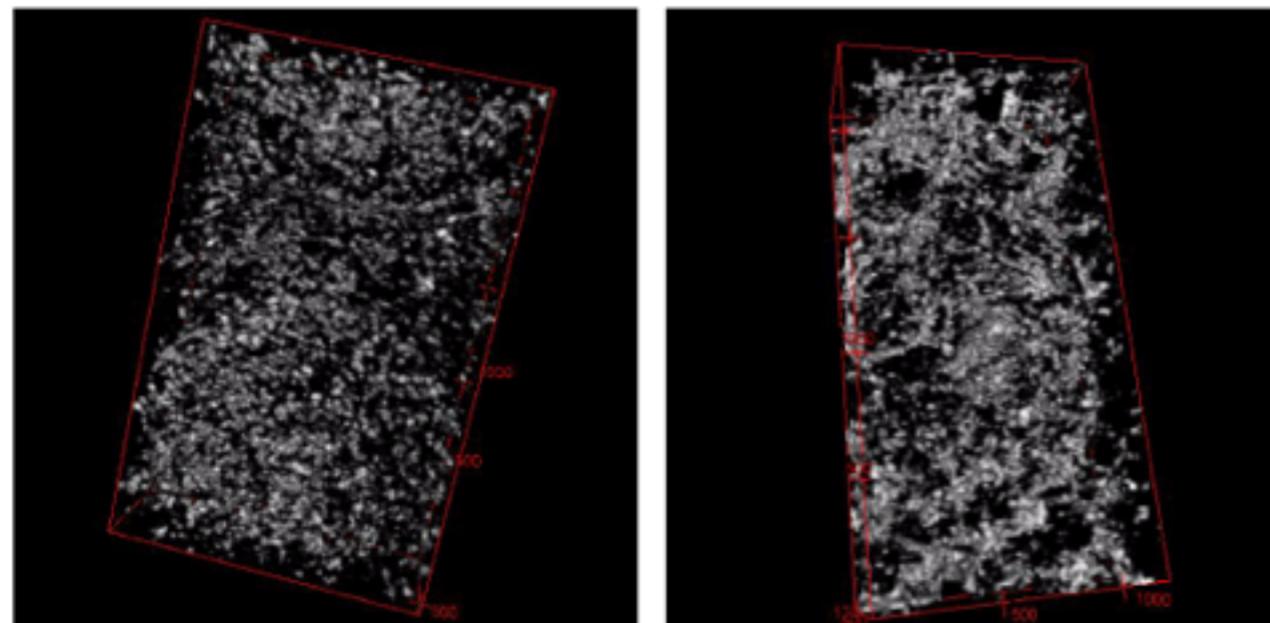




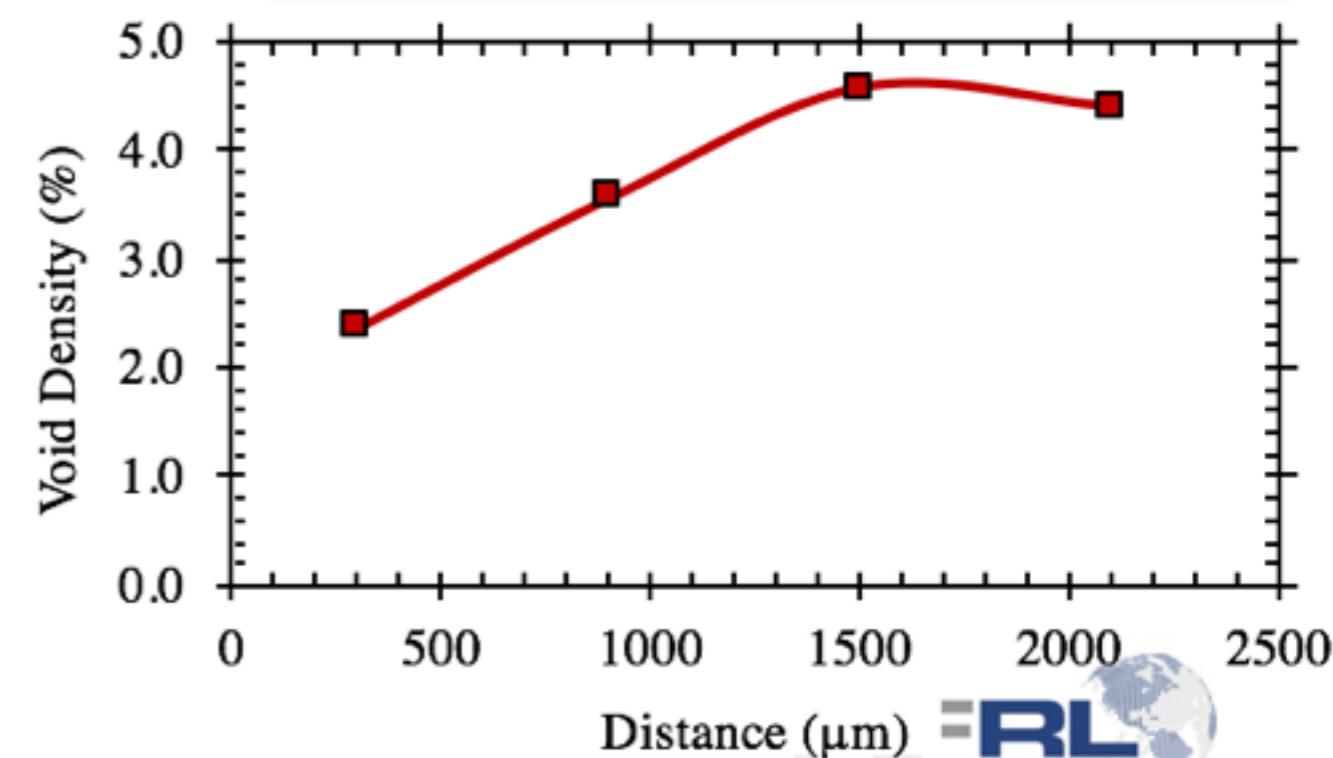
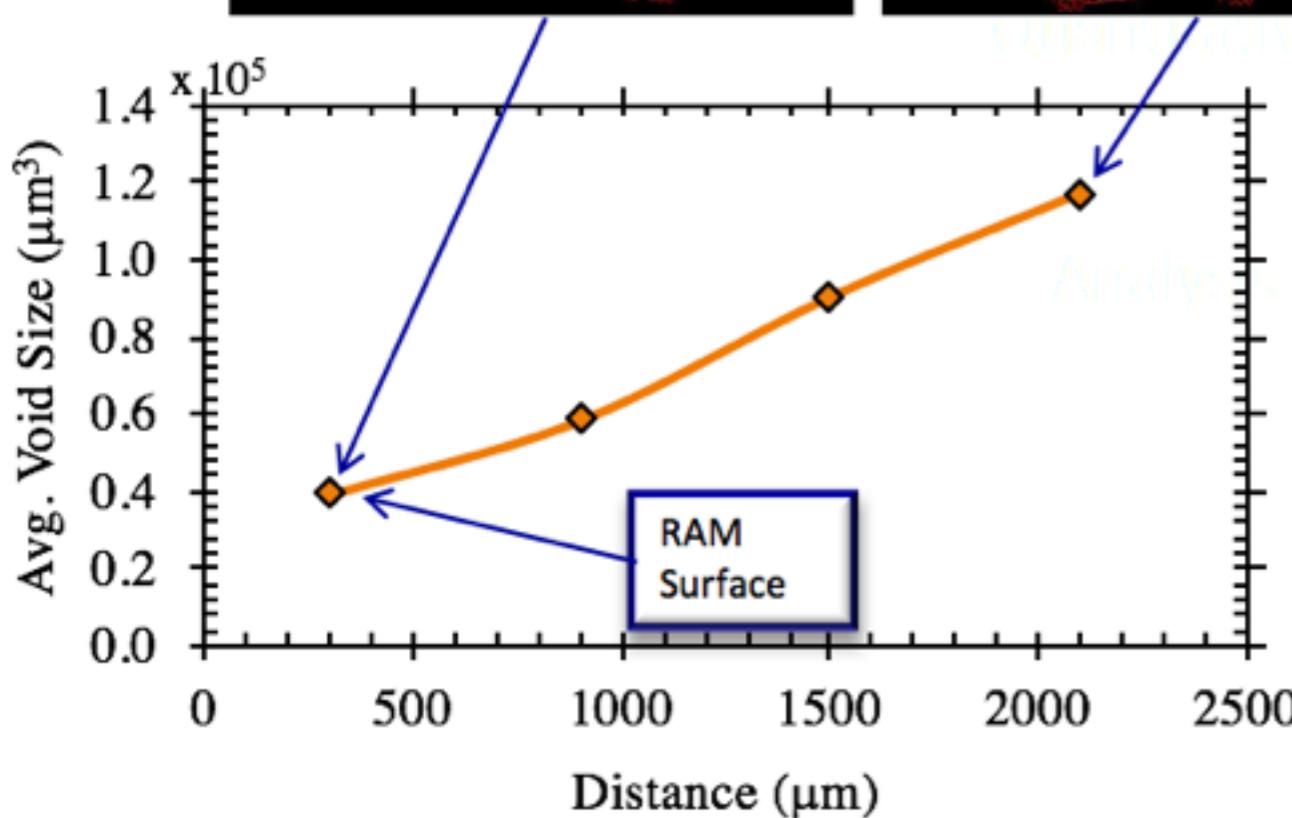
Class 1 XCMT Data



Class 1 data obtained for 3 mm pellet at 94% TMD



- Dynamic face of the press is correlating to higher cracking of crystals, i.e. higher observed calculated density
- Observed > 500 micron crystals with voids 20-60 μm in size in the center

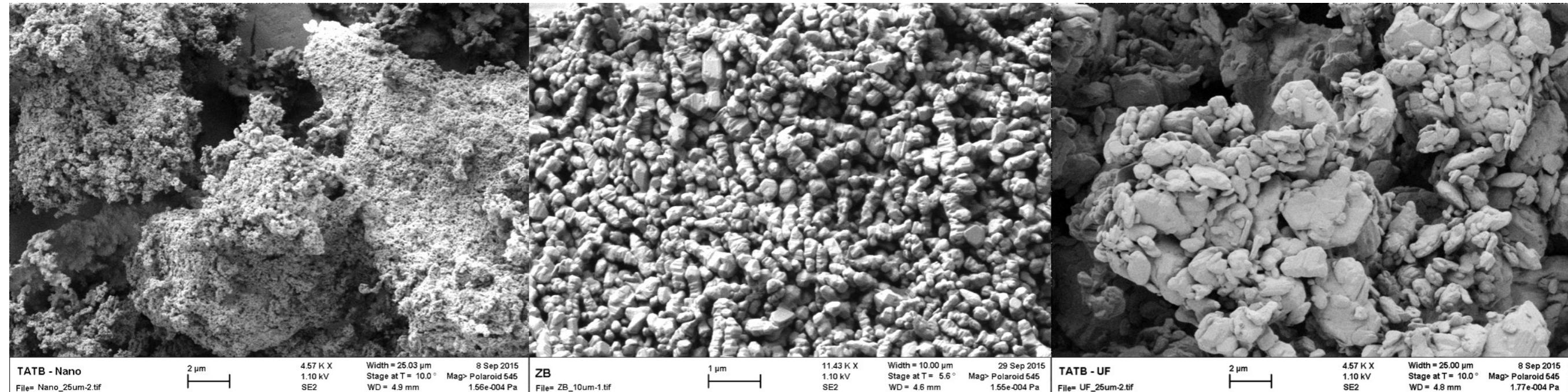


TATB STUDY: THREE ORDERS OF MAGNITUDE

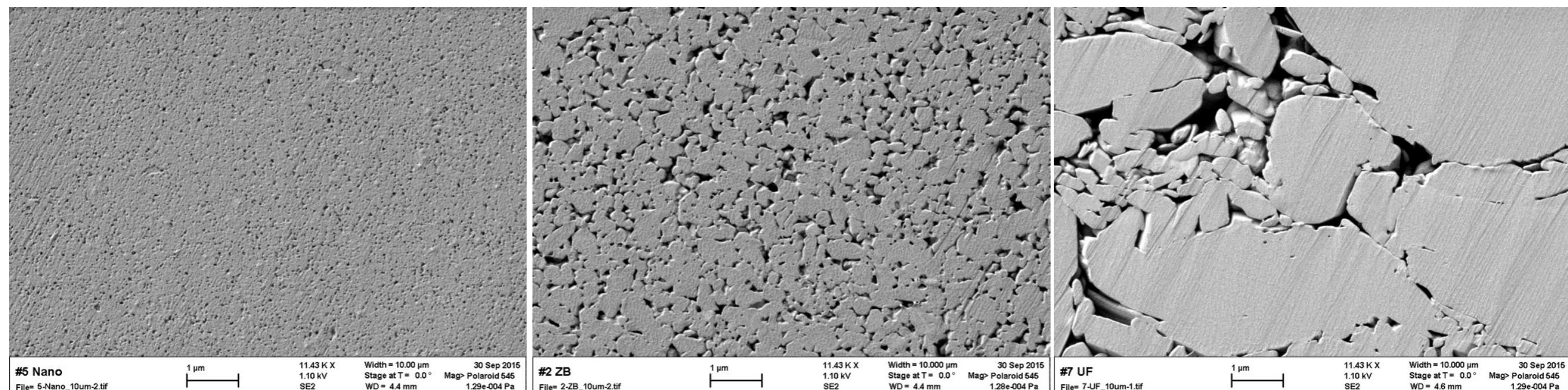
ARDEC

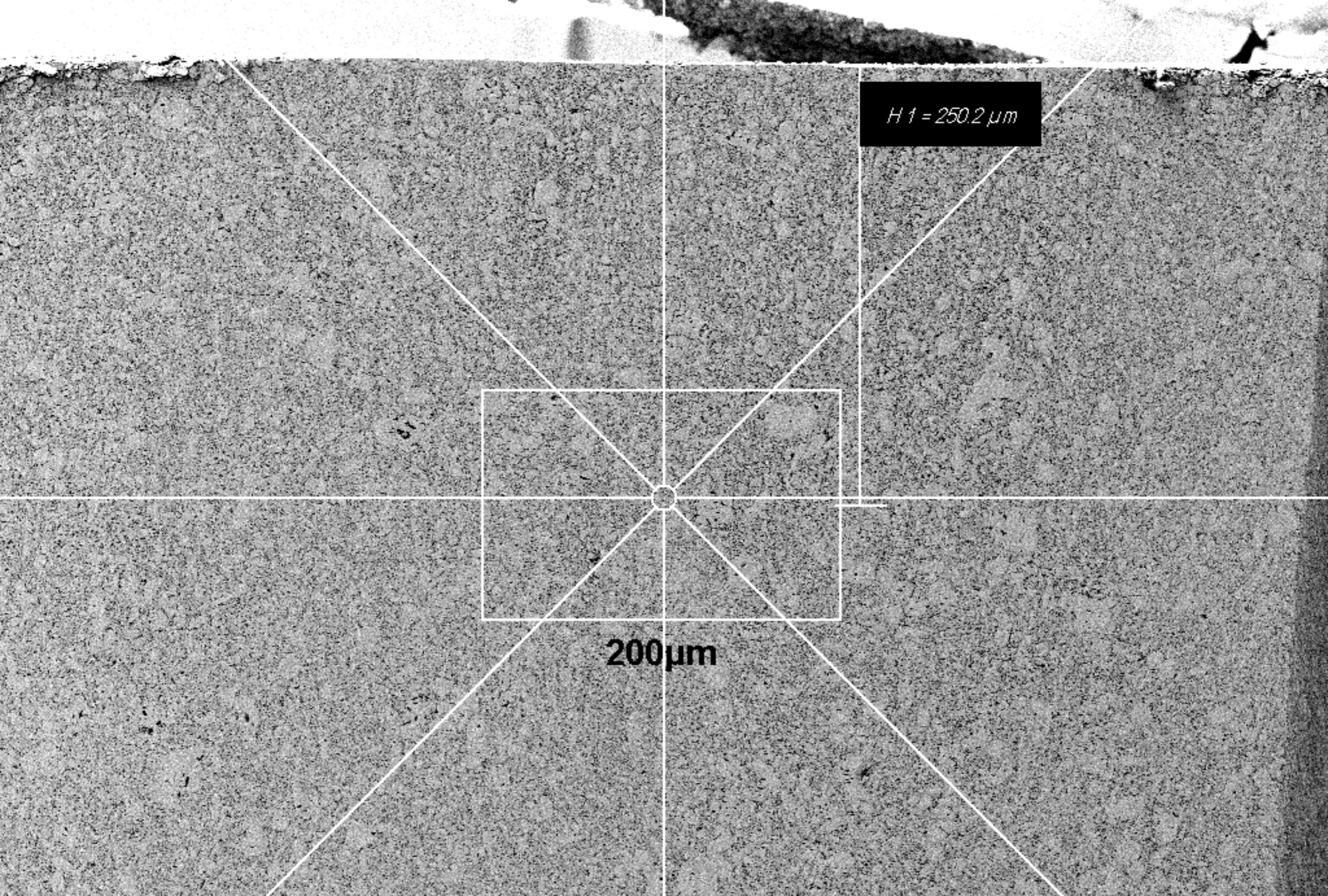
SNL

PANTEX



Pellets pressed to 80% TMD, ion-milled, SEM





TATB Ultra-Fine (7)

File= Ultra-Fine_IP_16K Area.tif

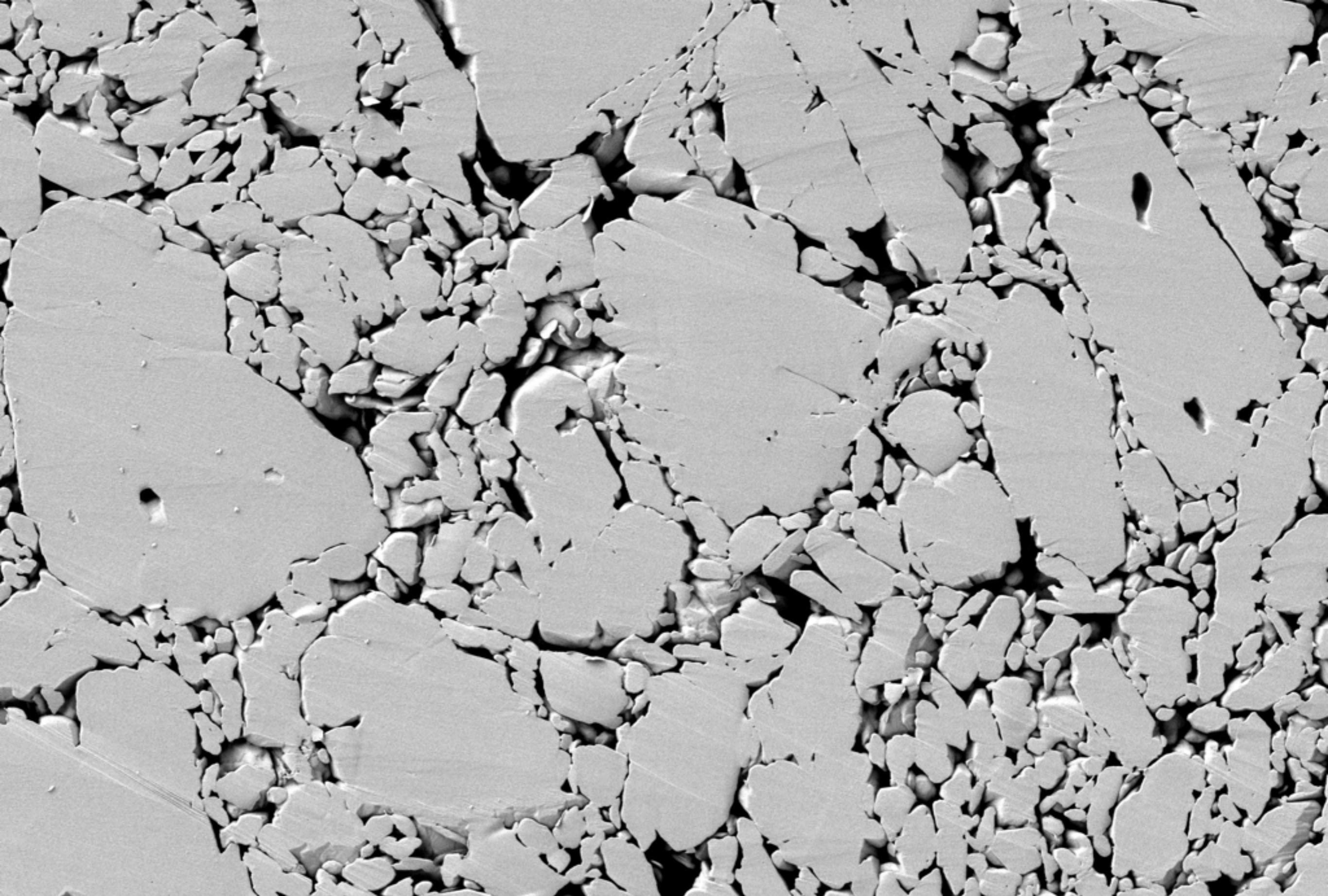
100 μm

151 X
1.10 kV
SE2

Width = 755.8 μm
Stage at T = 0.0 °
WD = 3.8 mm

Mag> Polaroid 545
0.00e+000 Pa

14 Jul 2016



TATB Ultra-Fine (7)



2 μ m

File= Ultra-Fine_IP_25um-2048.tif

4.57 K X

1.10 kV

SE2

Width = 25.00 μ m

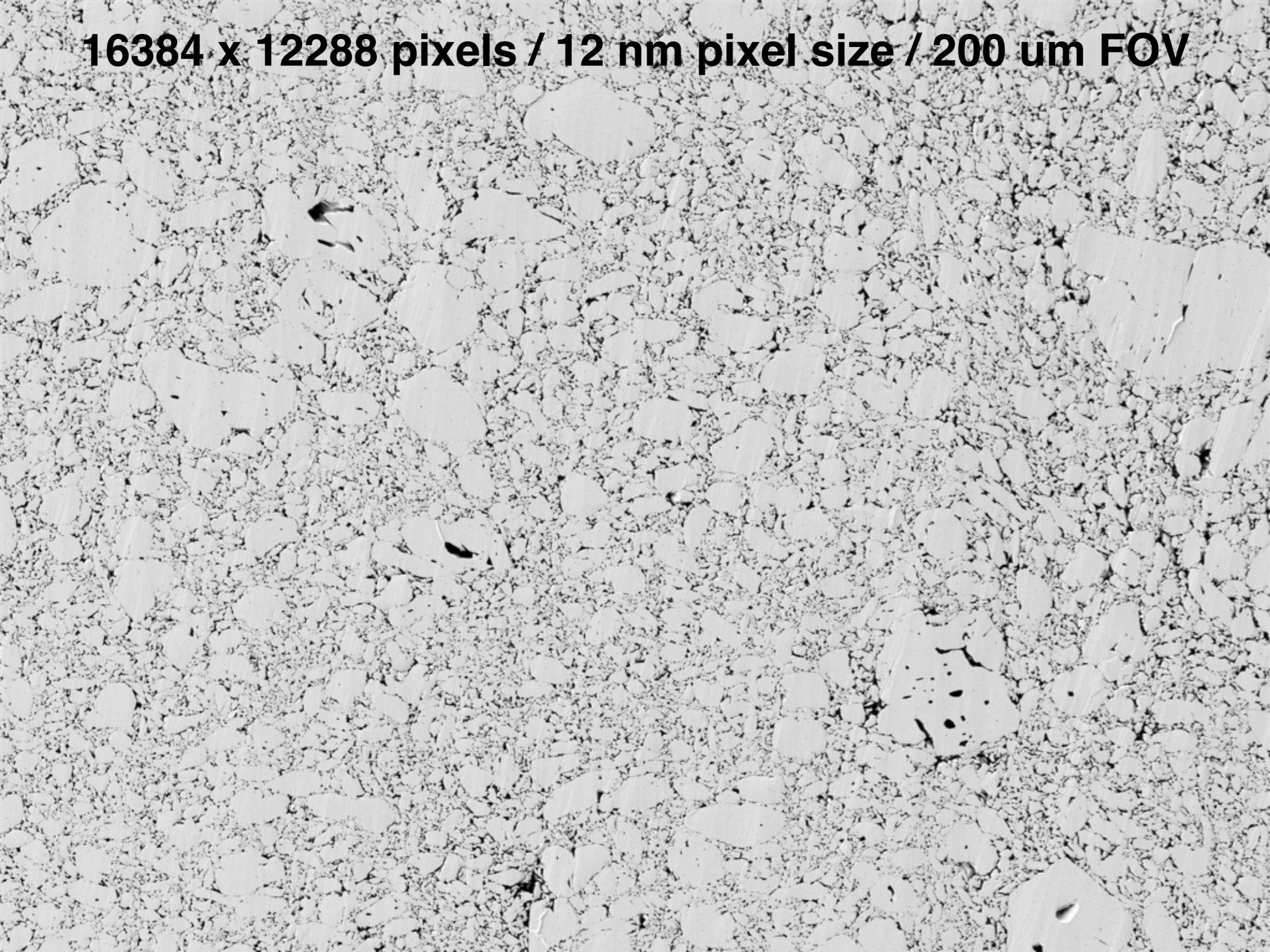
Stage at T = 0.0 ° Mag > Polaroid 545

WD = 4.5 mm

8 Jul 2016

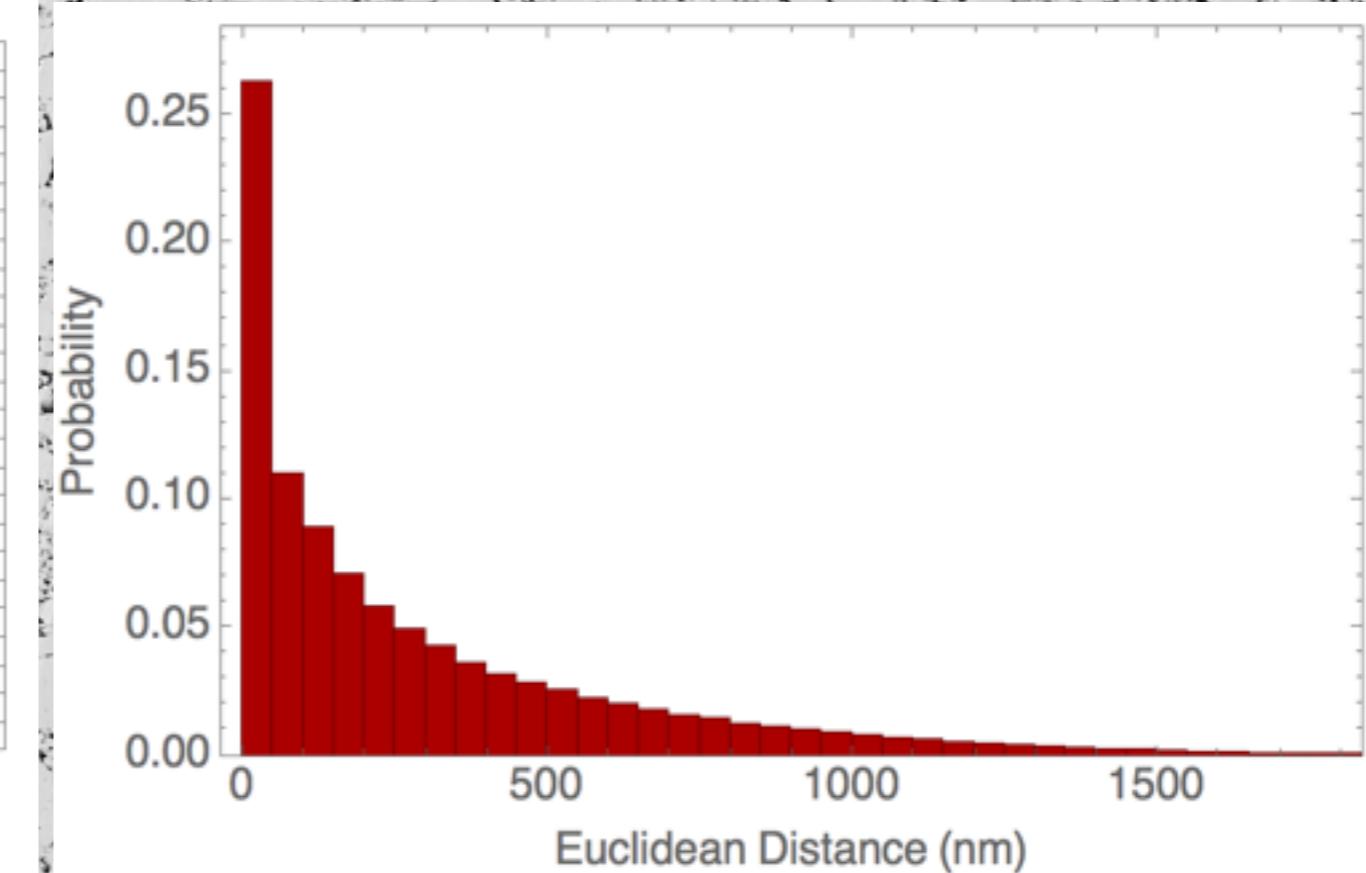
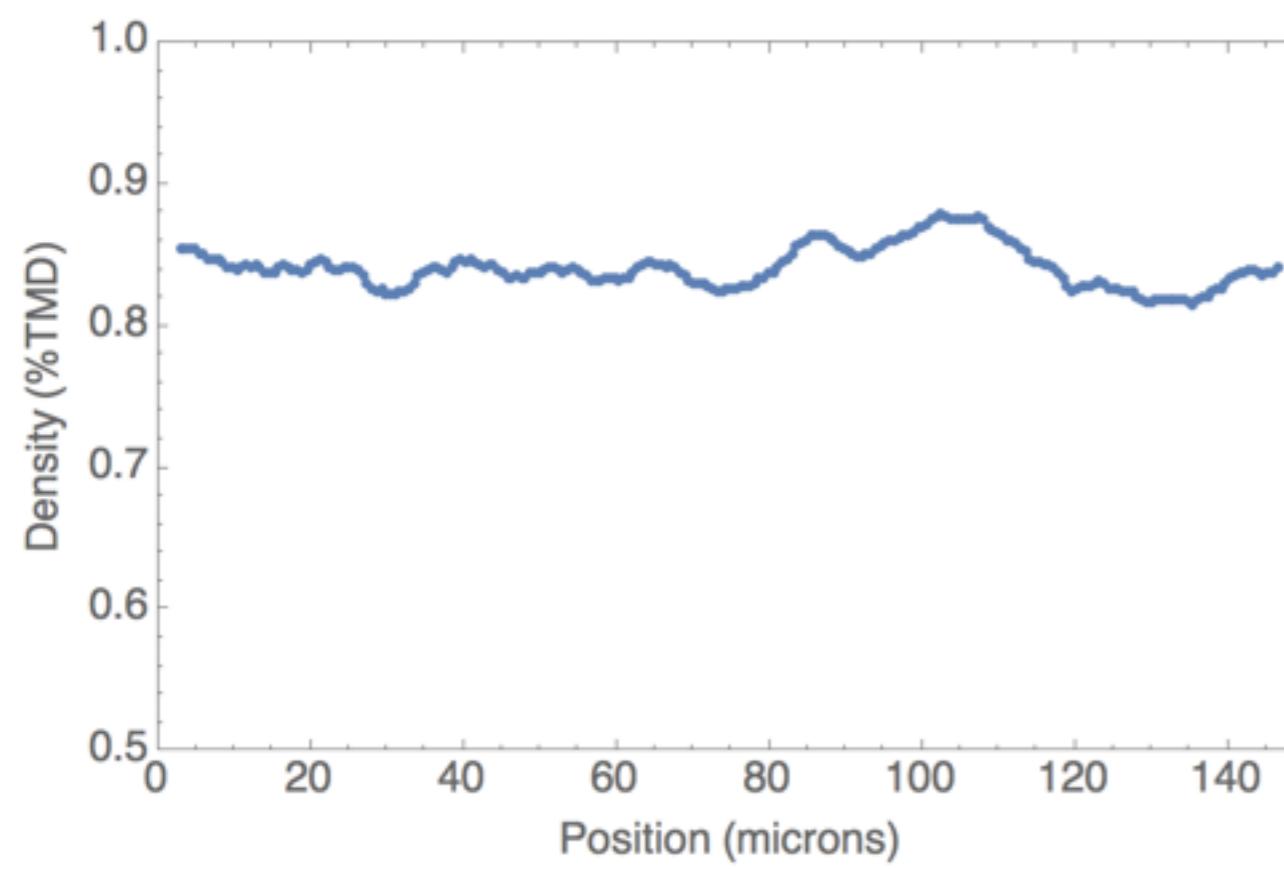
0.00e+000 Pa

16384 x 12288 pixels / 12 nm pixel size / 200 μm FOV

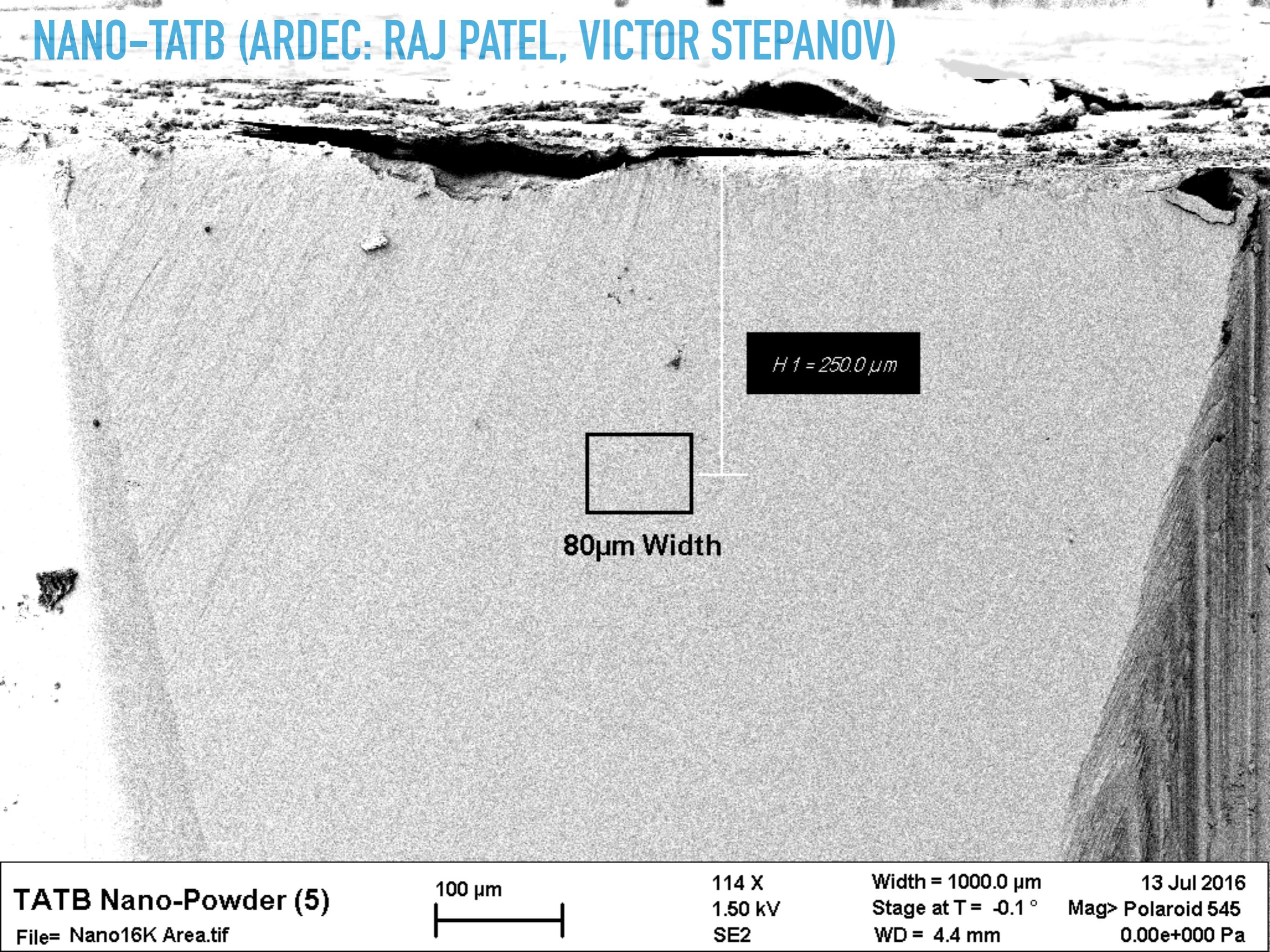


16384 x 12288 pixels / 12 nm pixel size / 200 μm FOV

80% TMD
500 Bin width
50 step size



NANO-TATB (ARDEC: RAJ PATEL, VICTOR STEPANOV)



TATB Nano-Powder (5)

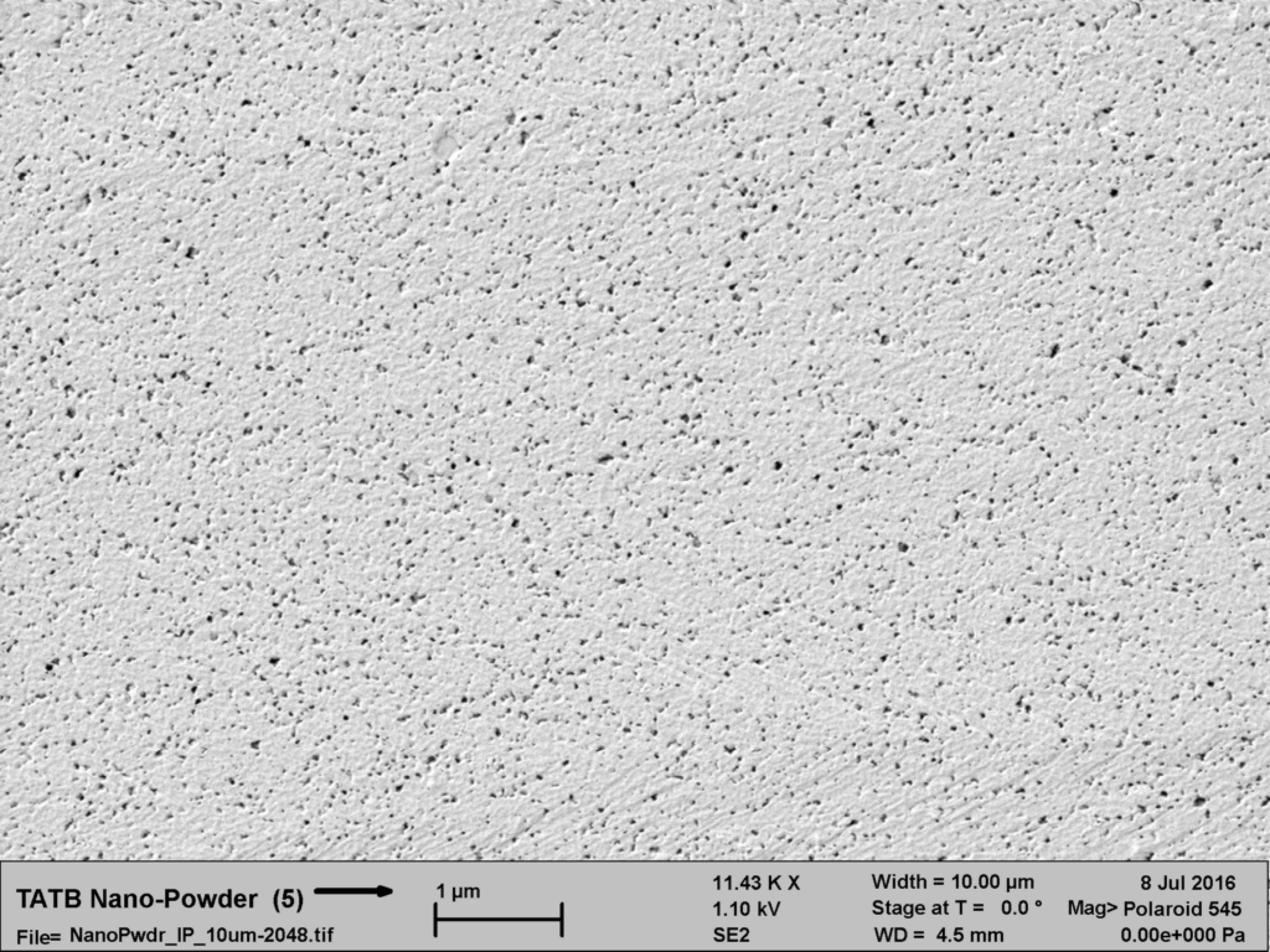
File= Nano16K Area.tif

100 μm

114 X
1.50 kV
SE2

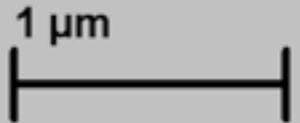
Width = 1000.0 μm
Stage at T = -0.1 °
WD = 4.4 mm

13 Jul 2016
Mag> Polaroid 545
0.00e+000 Pa



TATB Nano-Powder (5) 

File= NanoPwdr_IP_10um-2048.tif



11.43 K X

1.10 kV

SE2

Width = 10.00 μm

Stage at T = 0.0 ° Mag> Polaroid 545

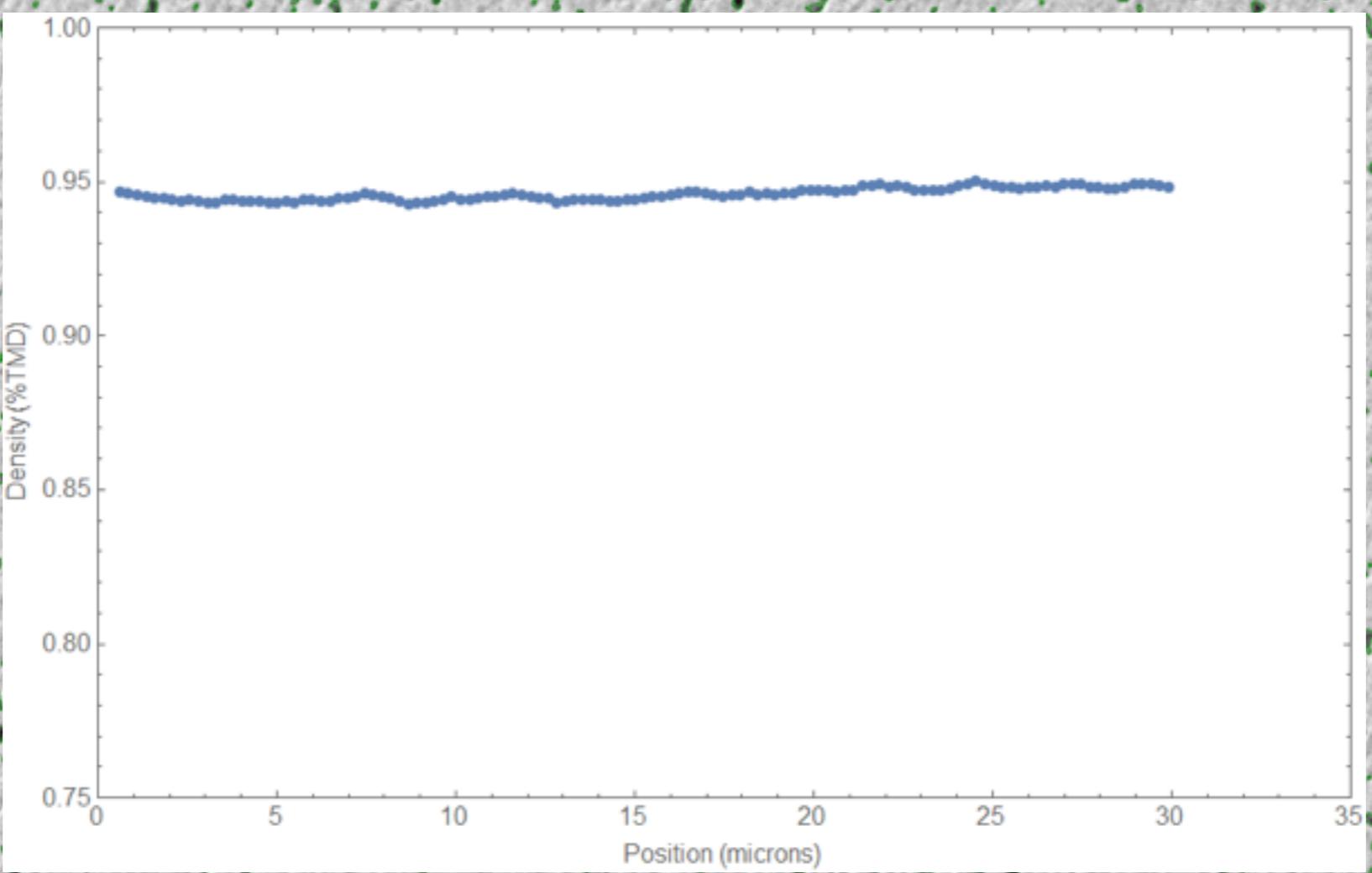
WD = 4.5 mm

8 Jul 2016

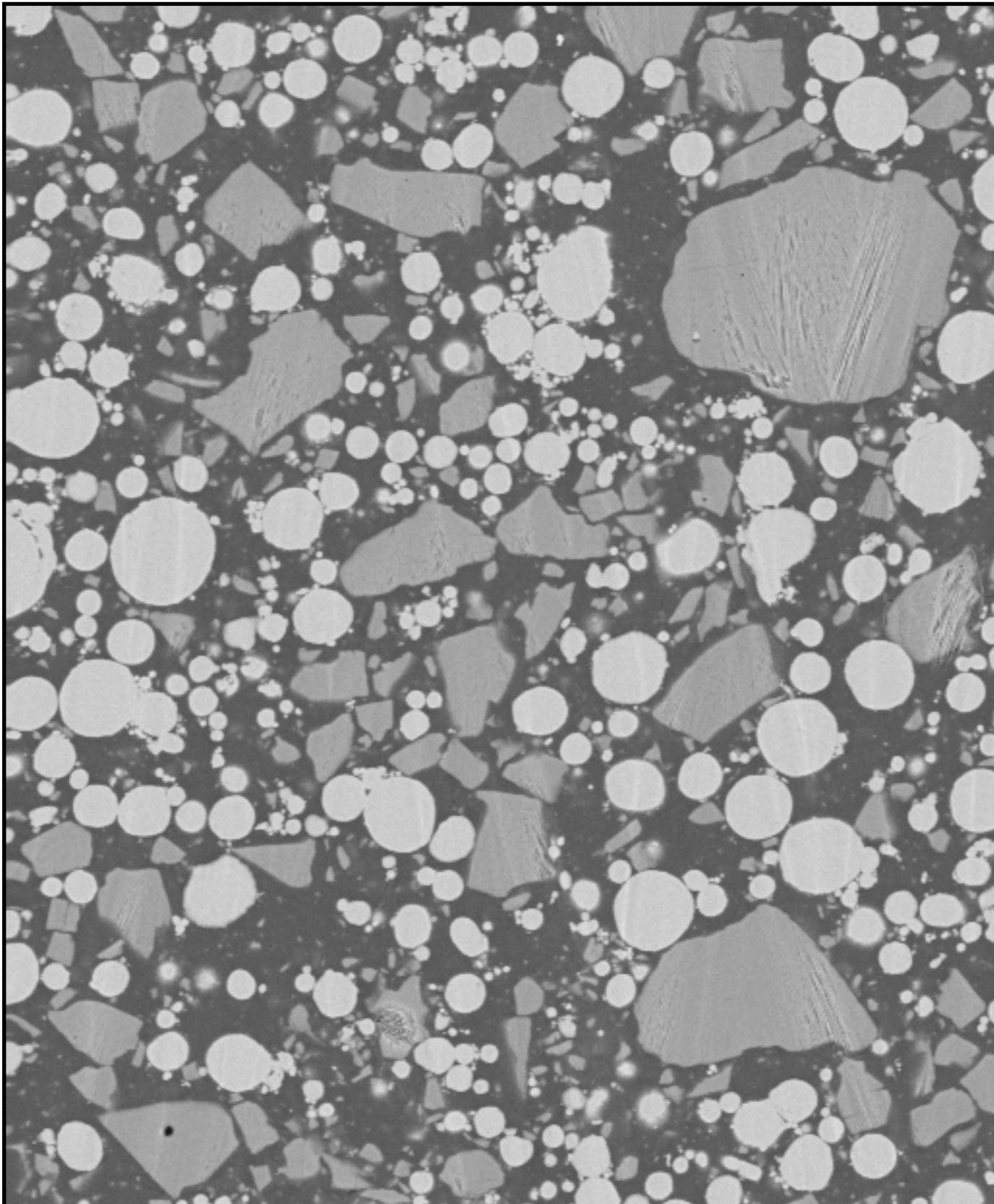
0.00e+000 Pa



Density to high? Location in pellet?
Maybe even the SEM can't resolve the pores.
Perhaps AFM? FIB into center of pellet?

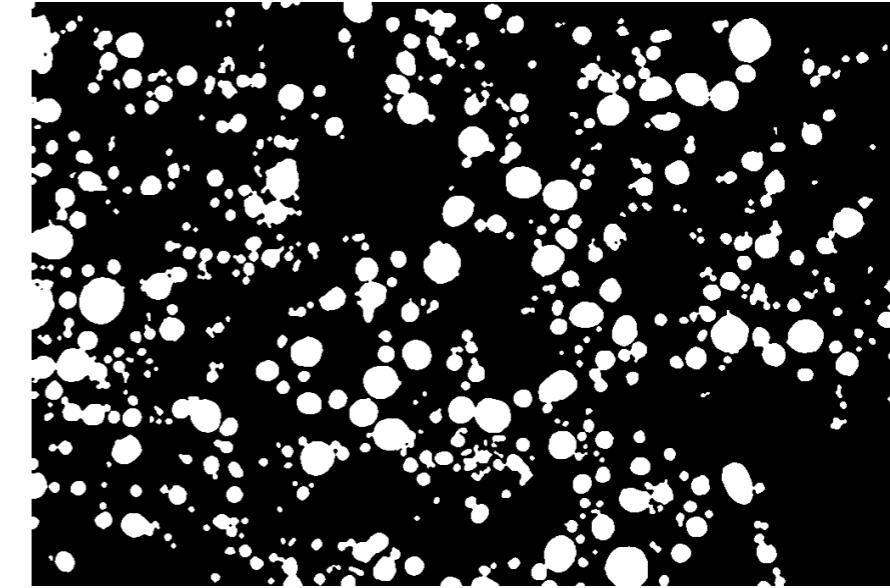


COMPOSITE PROPELLANT

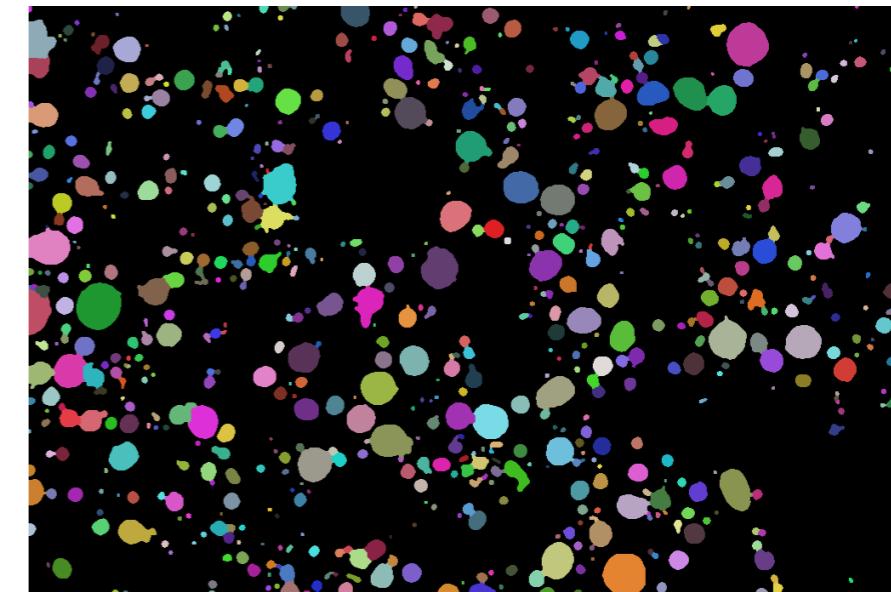


TP-H-3340 TU126280
Ion Polished Surface
File= 500um-BSE-1.tif

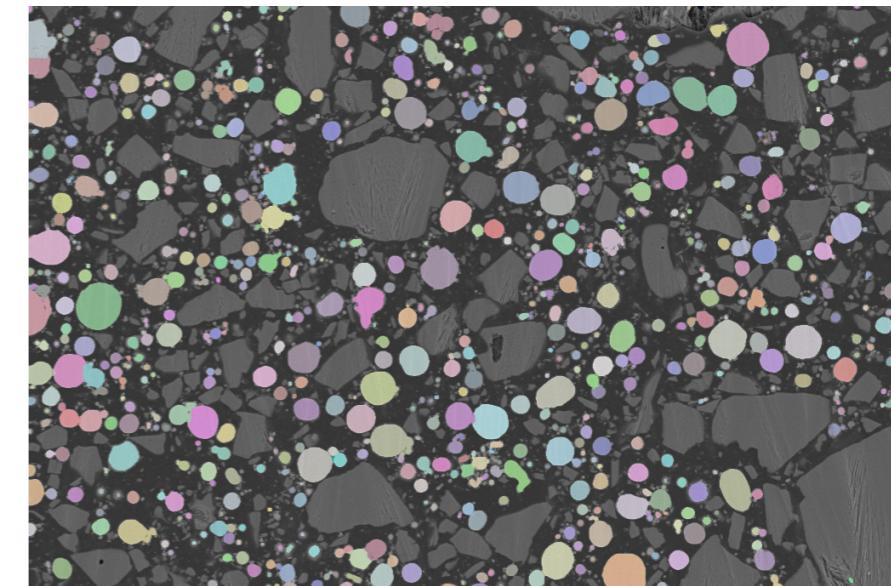
20 μ m
H



Binary image of aluminum particles

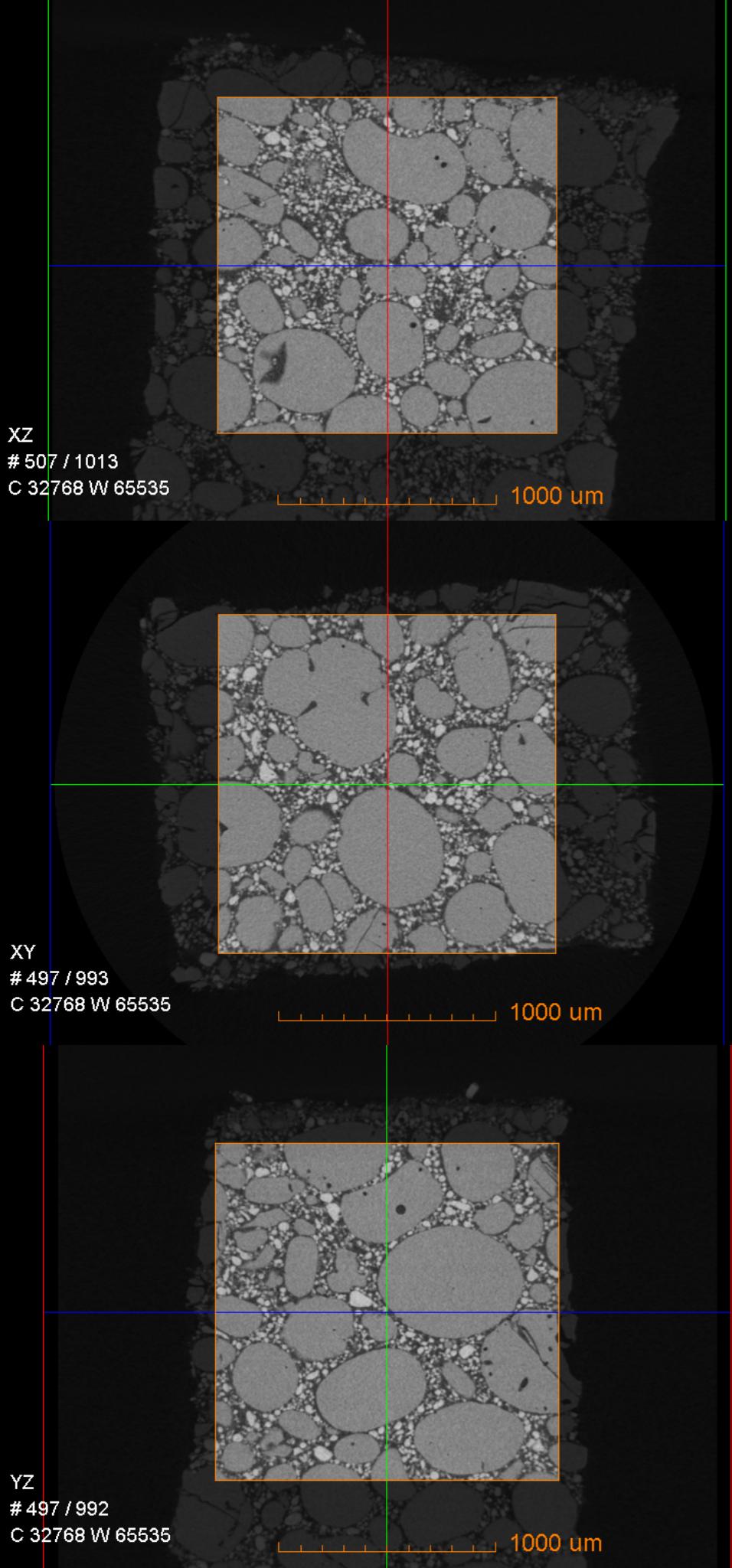


Identify and measure individual particles

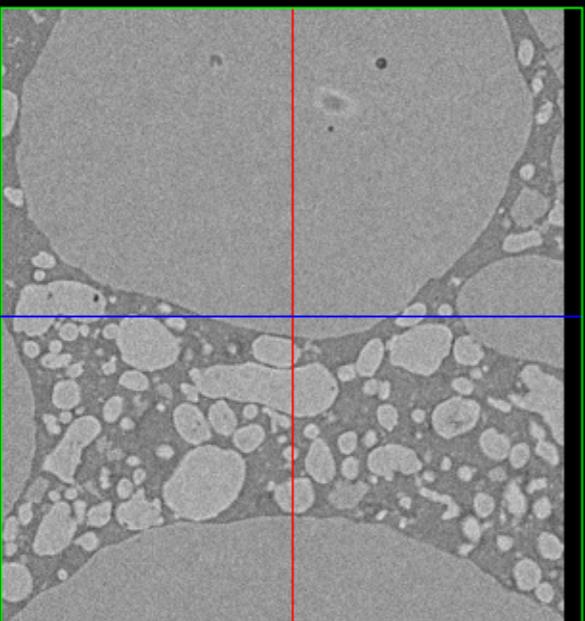


Overlay of aluminum particles onto original

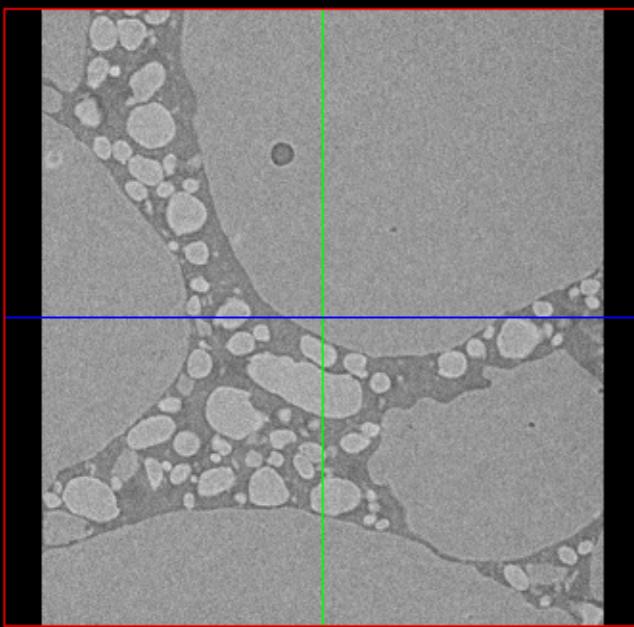
APCP, 3 μm pixels, 3 mm FOV



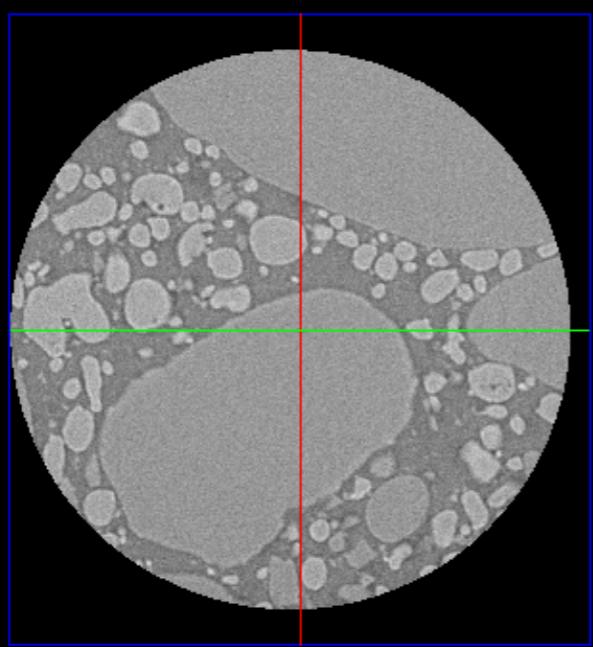
480 nm pixels, 437 um FOV



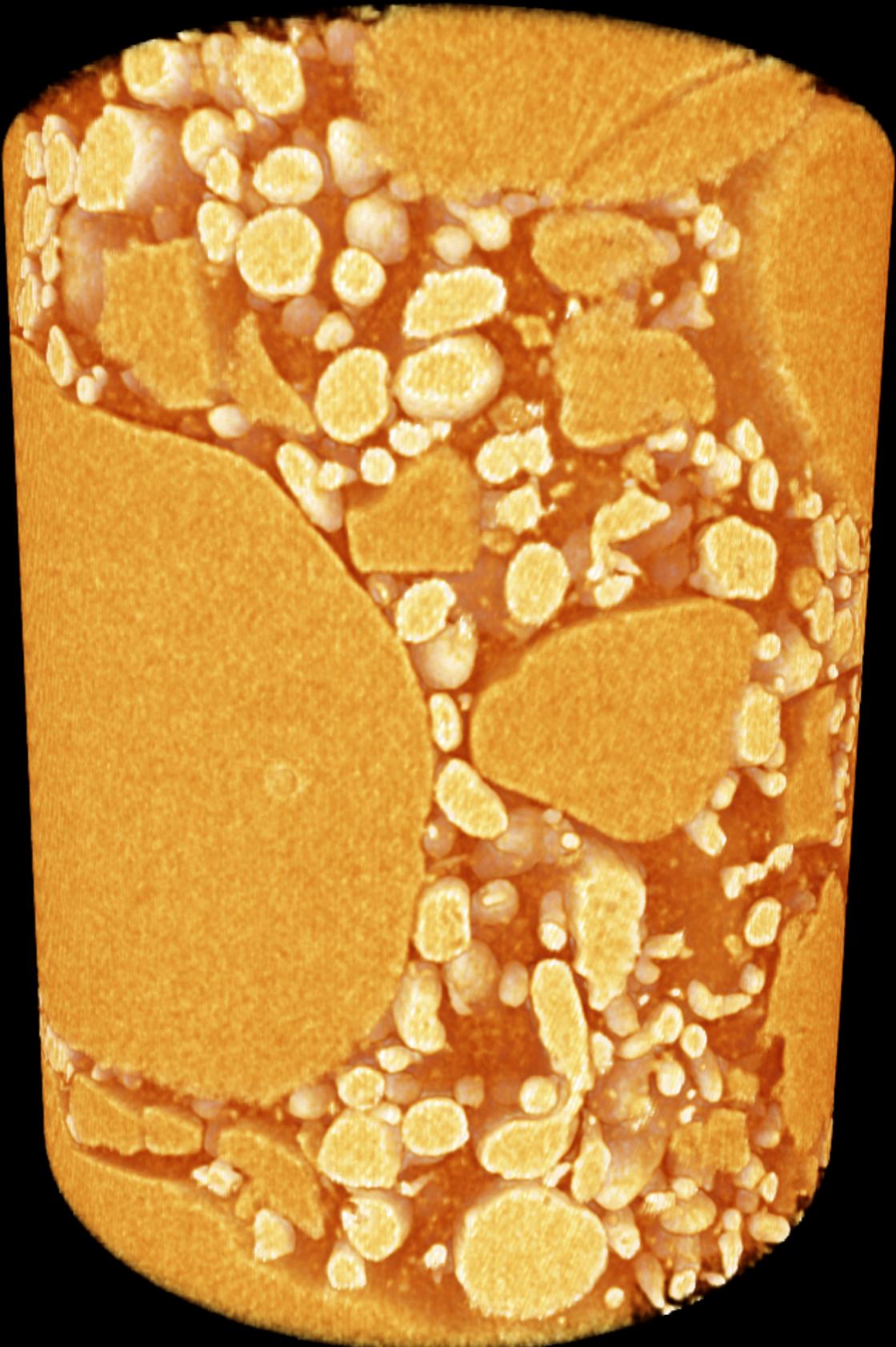
XZ
498 / 994
C 31548 W 63096



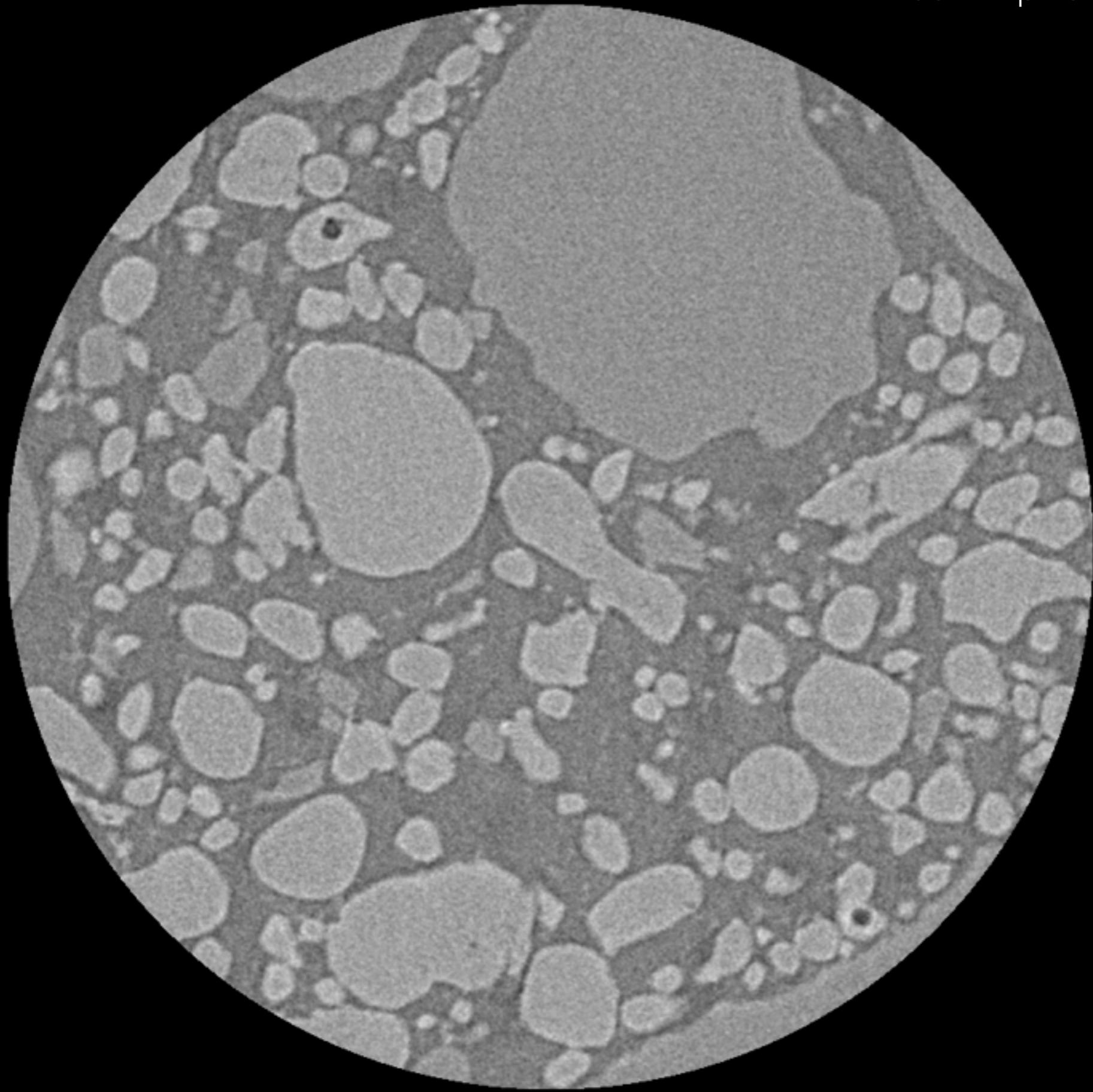
YZ
457 / 912
C 31548 W 63096



XY
481 / 960
C 31548 W 63096



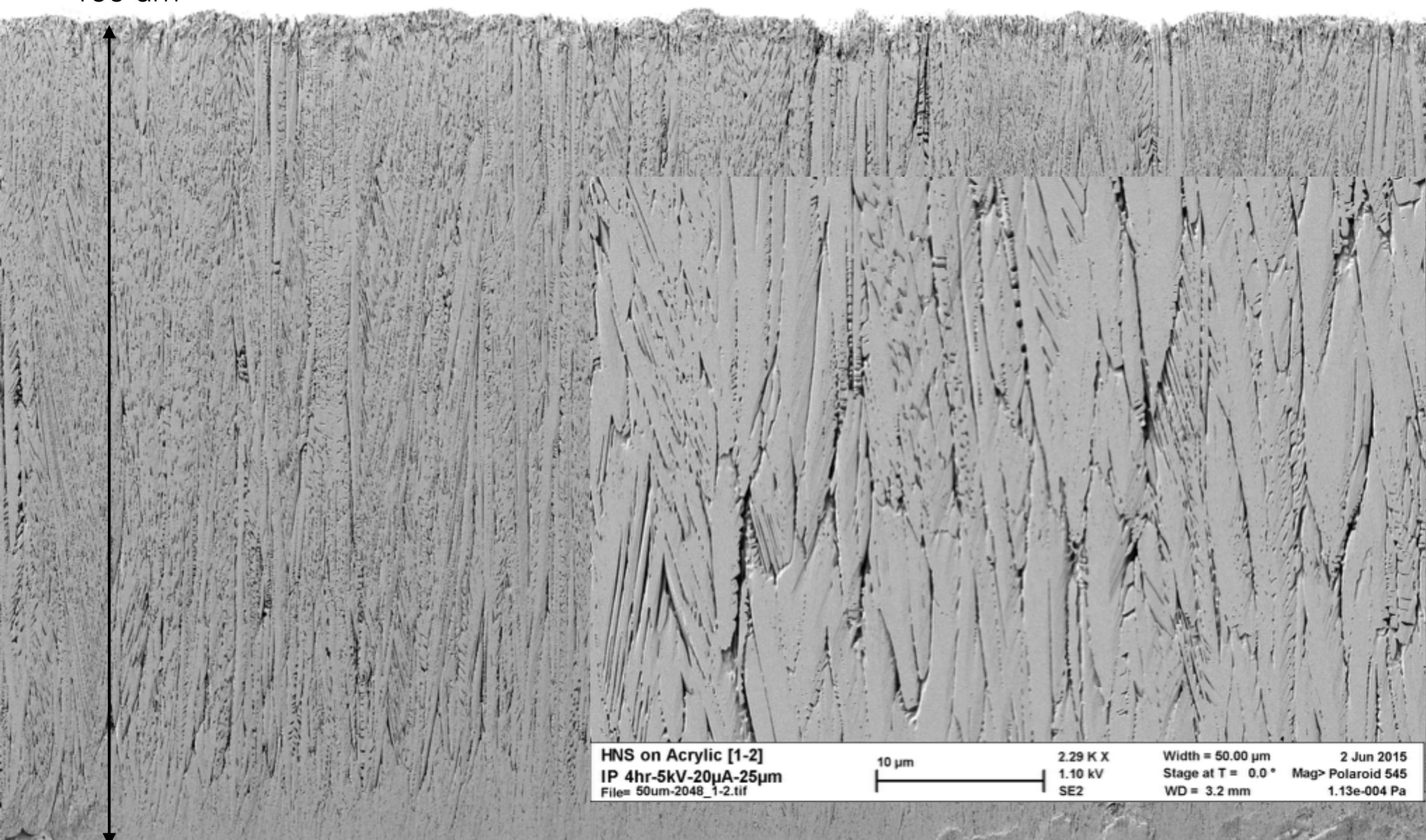
480 nm pixels, 437 μm FOV



Samples: Vapor-deposited HNS (50-200um thick)

~100 um

These samples are extremely cool



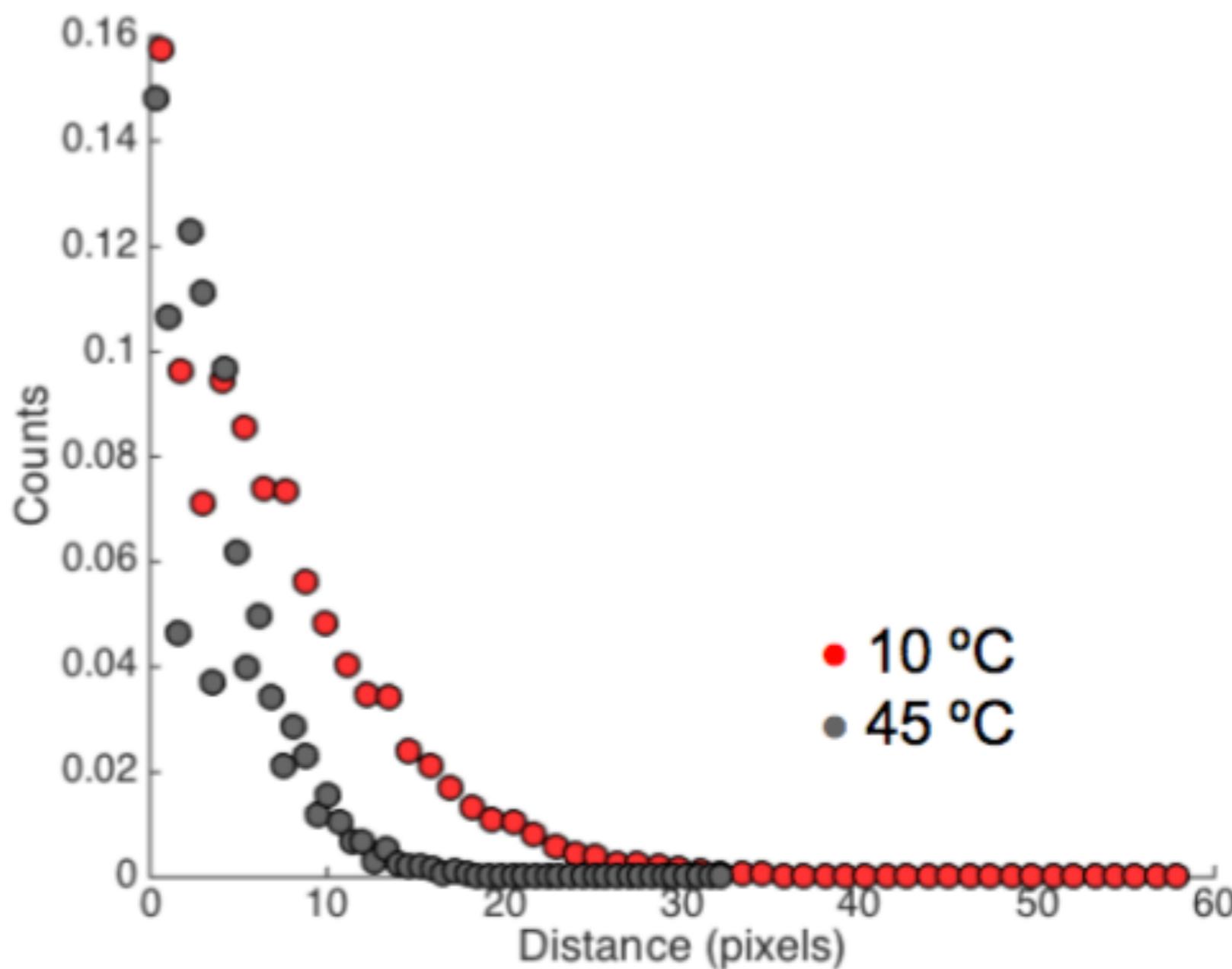
SEM of ion milled cross-section

10 C



45 C

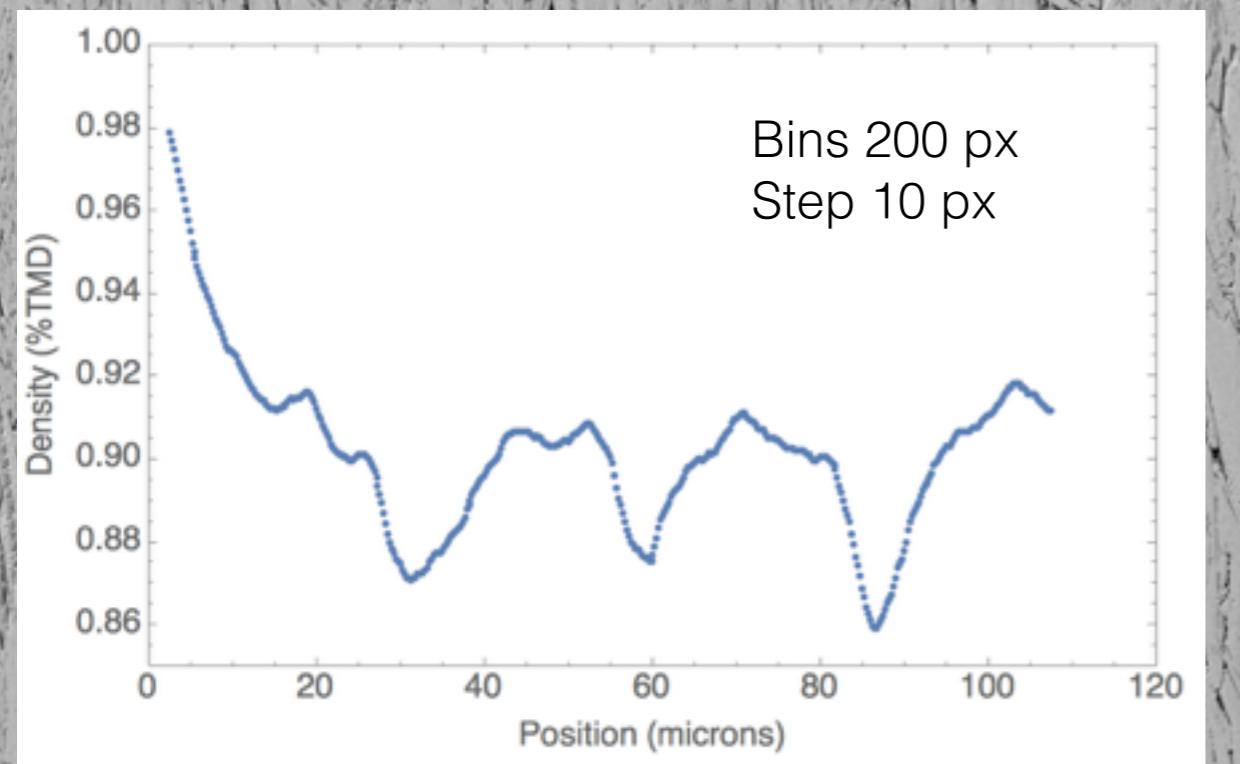




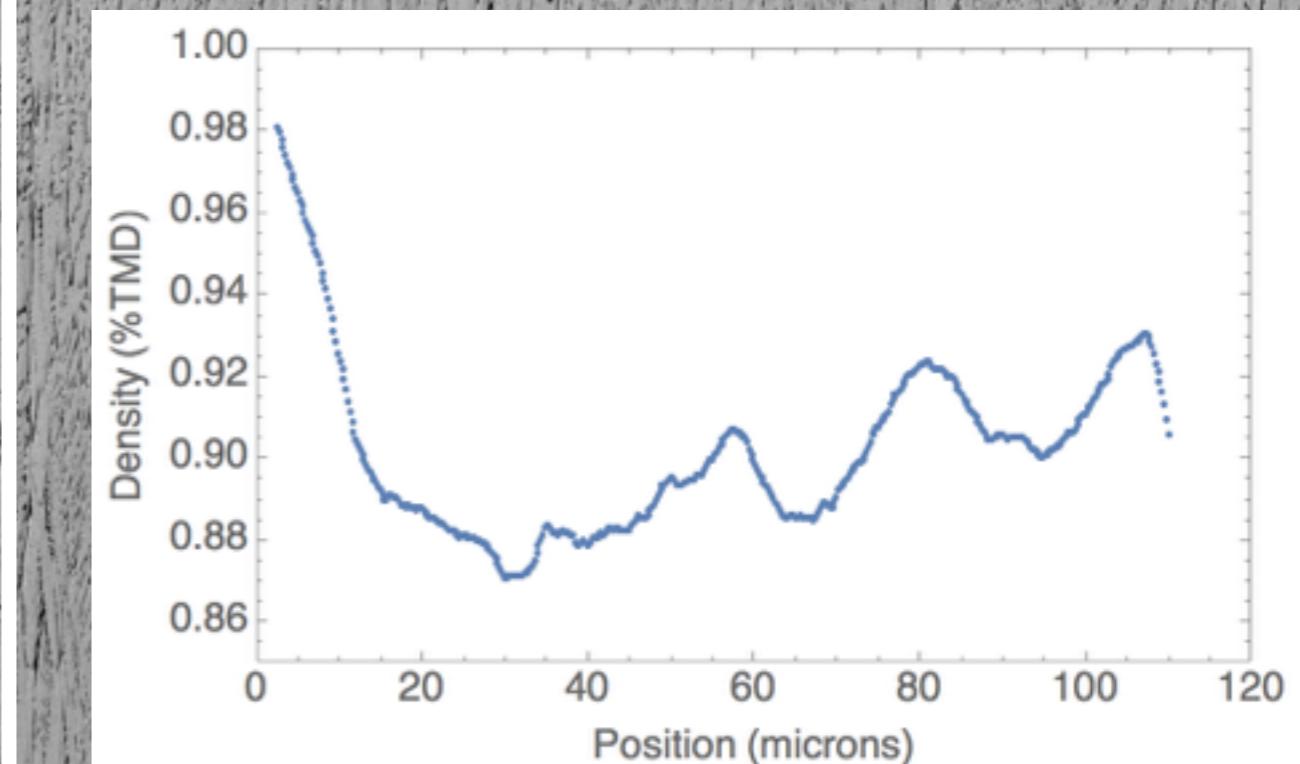
Histogram of a Euclidean distance map indicating distances from any pixel to a pore in HNS films deposited at 10 °C and 45 °C.

DENSITY VARIATION IN HNS FILMS

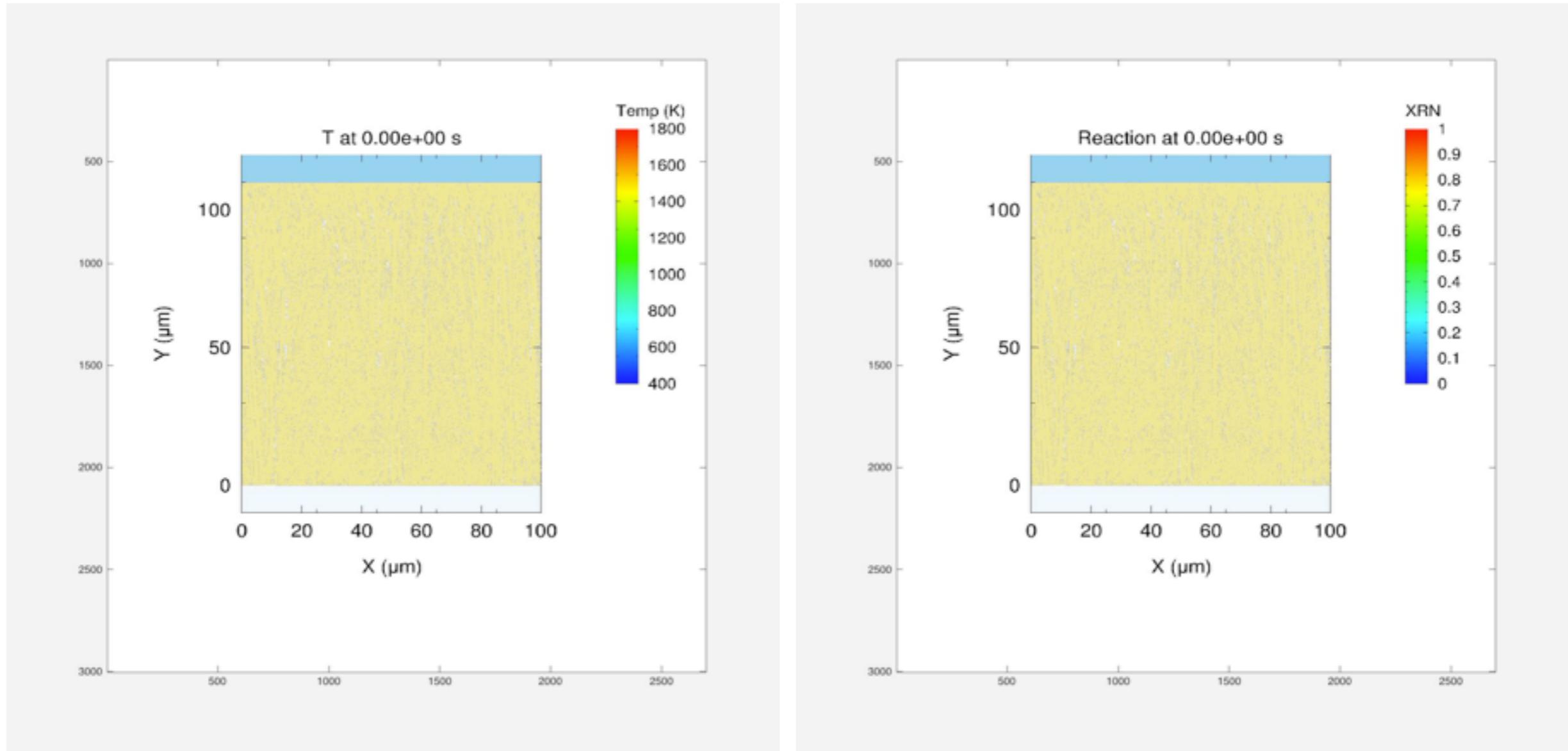
10 C



45 C

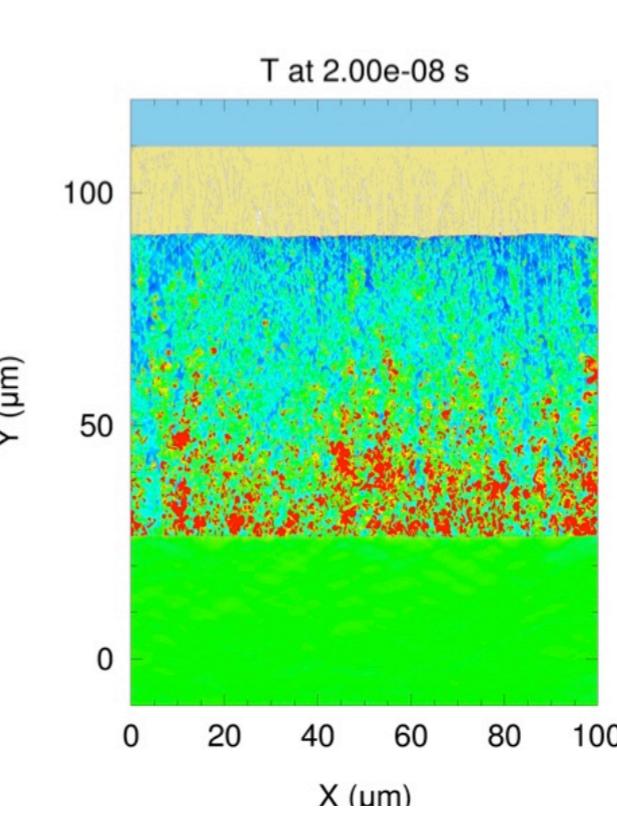
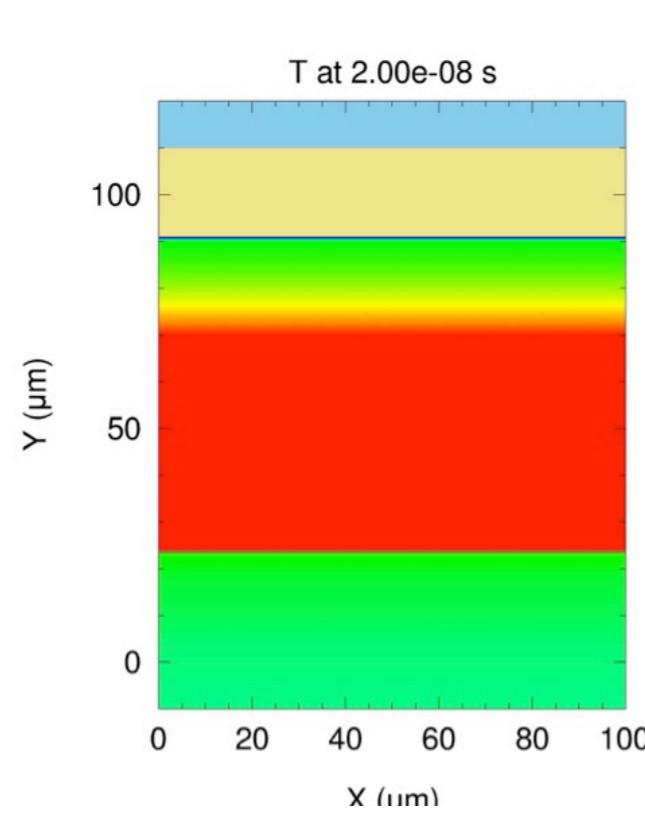


Grain-scale (mesoscale) simulation of HNS initiation

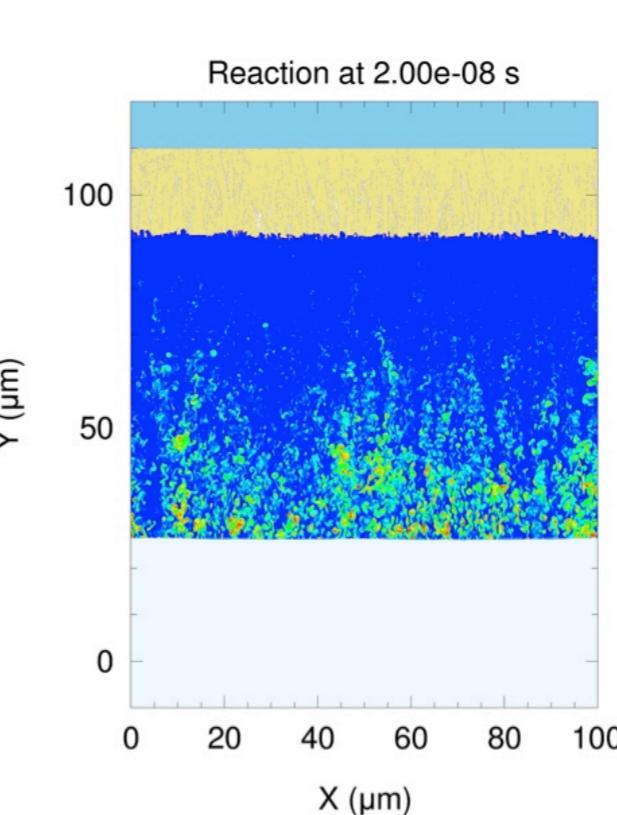
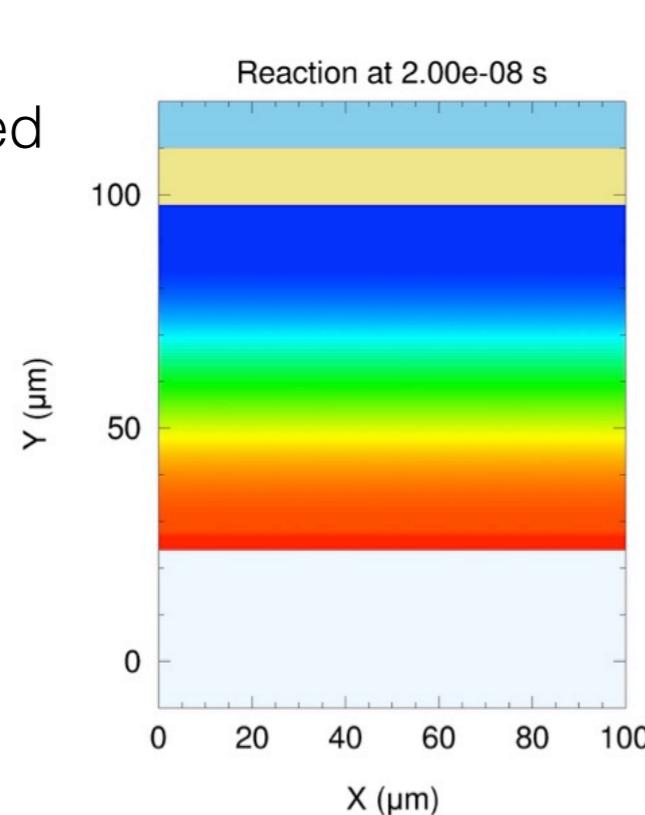


Continuum vs. mesoscale simulation, 3 km/s impact

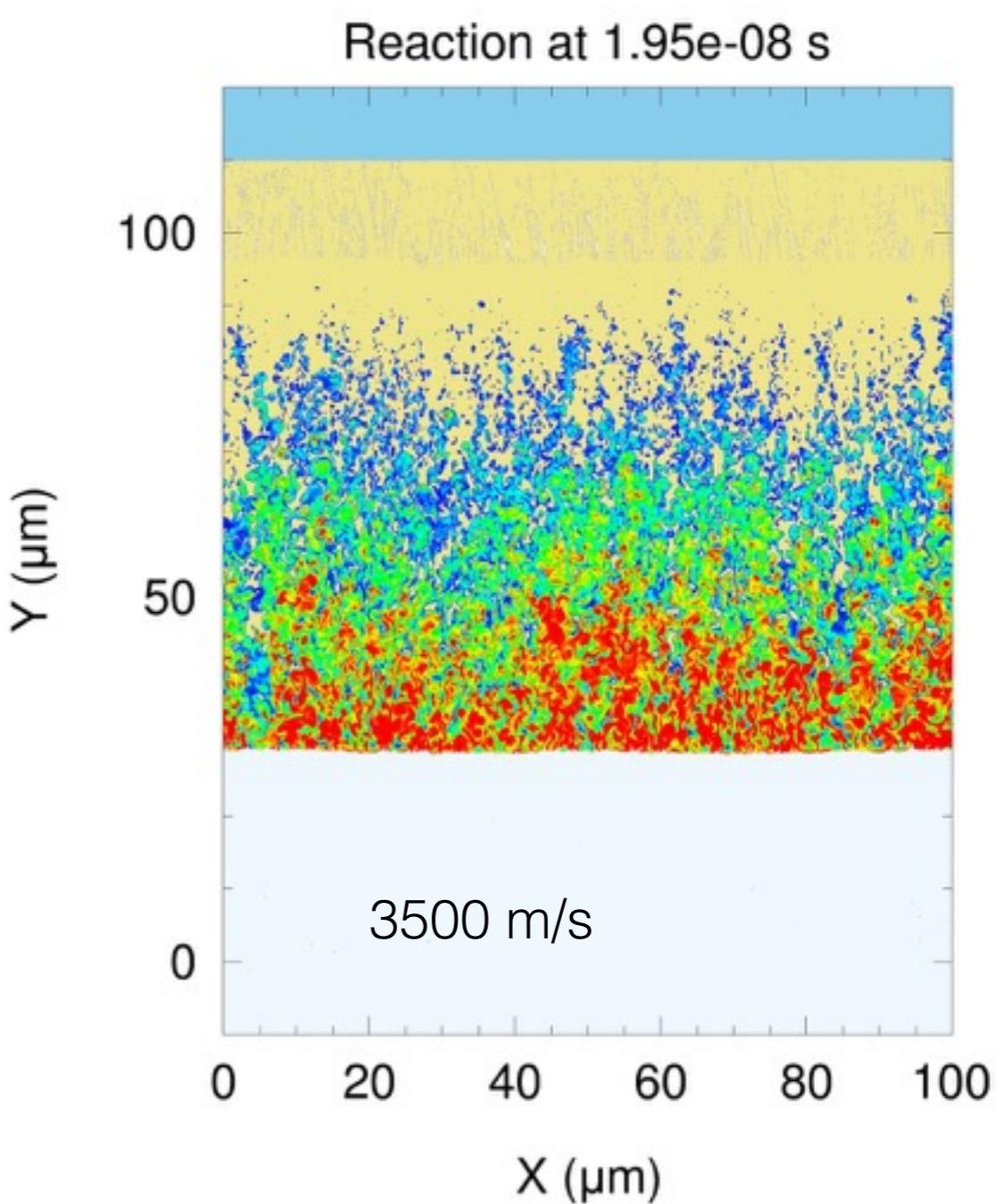
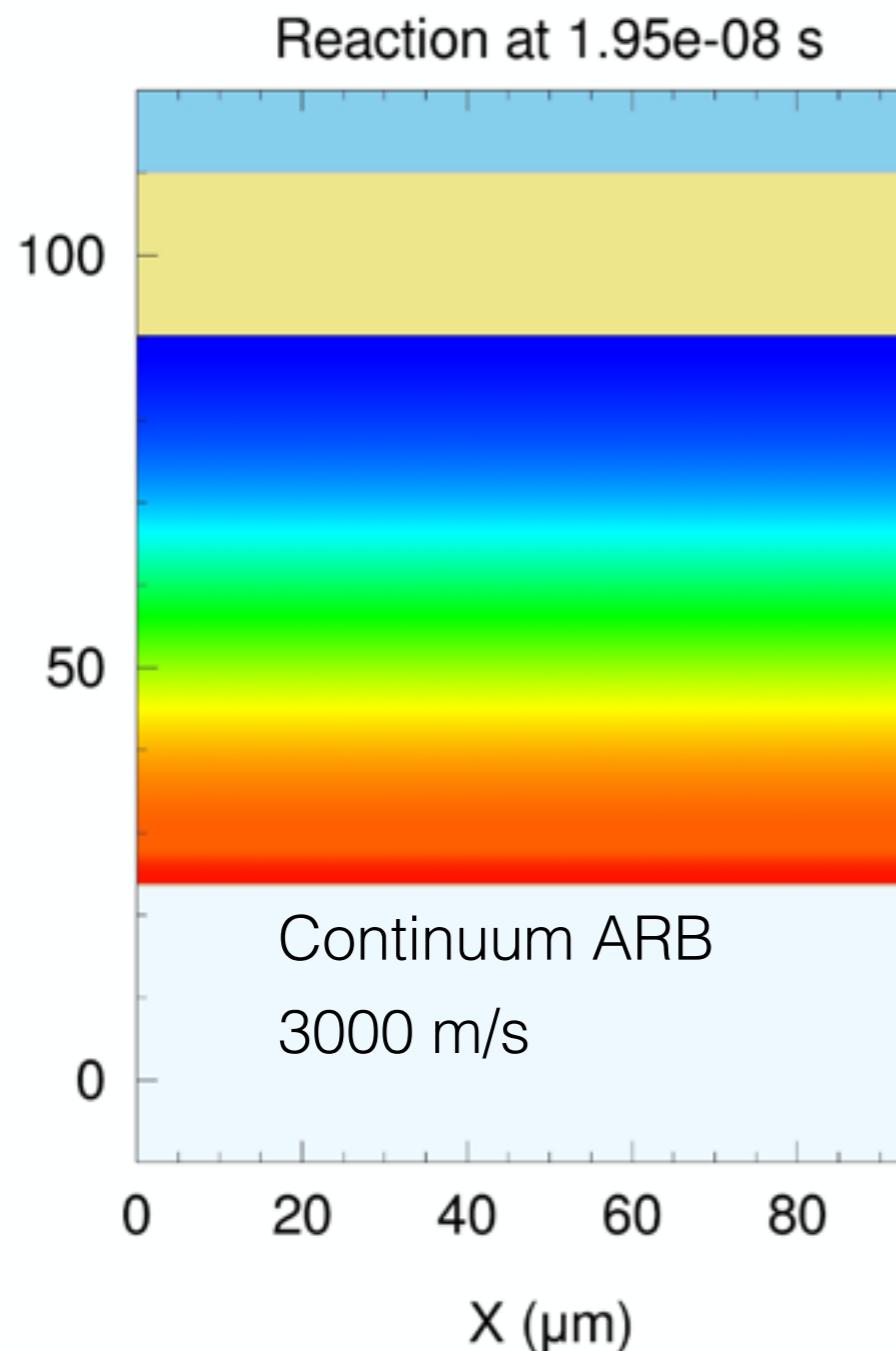
Temperature



Fraction Reacted



Continuum vs. Mesoscale



First-principles based reactants EOS (tabular)
Sesame table product EOS (historical)
Arrhenius reactive burn (ARB) with new and old parameters

Center for Integrated Nanotechnology (CINT)

www.cint.lanl.gov





CL-20-05 ~300 μ m down
Ion Polished
File= 05_100um-300down.tif

10 μ m*

Mag = 1.14 K X
Width = 100.0 μ m
EHT = 1.20 kV

Wrap-up:

- FIB/SEM, Ar Ion, xCT
- What does the modeling community need?
- What resolution and FOV?
- Resolution -> mesh
- Sample size?
- ?

